

Features

- Fully synchronous; all signals registered on positive edge of system clock.
- Internal pipelined operation; column address can be changed every clock cycle.
- Dual internal banks for hiding row precharge; Each bank is 128k x 32.
- Programmable burst lengths: 1, 2, 4, 8 or full page
- Programmable $\overline{\text{CAS}}$ Latency: 1, 2, 3
- 8 column Block Write and Write-per-Bit modes
- 100Mhz Block Write operation
- Two Color Registers
- Independent byte operation via DQM_{0-3}
- Auto Precharge and Auto Refresh modes
- 1K Refresh cycles/16ms
- 1K Refresh cycles/64ms, 128ms, 256ms for Self Refresh parts
- LVTTL- compatible inputs and outputs
- Supply $3.3\text{V} \pm 0.3$
- 100 - pin LQFP (0.65mm lead pitch)

| Options | Marking |
|---|---------|
| Timing | |
| 10ns Access (≤ 100 Mhz clock rate) | -10 |
| 12ns Access (≤ 83 Mhz clock rate) | -12 |
| 15ns Access (≤ 66 Mhz clock rate) | -15 |
| Self Refresh (Special part) | P |
| Plastic Package 100-pin LQFP (0.65mm lead pitch) | |

Key Timing Parameters

| Speed Grade | Clock Frequency (MHz) | Access Time (ns) | Setup Time (ns) | Hold Time (ns) |
|-------------|-----------------------|------------------|-----------------|----------------|
| -10 | 100 | 9 | 3.0 | 1.0 |
| -12 | 83 | 11 | 3.5 | 1.5 |
| -15 | 66 | 13 | 4.0 | 2.0 |

Description

The IBM 256K x 32 SGRAM is a high speed 8Mb CMOS SDRAM with built-in graphics features. It is internally configured as a dual bank 128K x 32 SDRAM with a synchronous interface (all signals are registered on the positive edge of the clock signal CLK). Each bank is organized as a 512 rows x 256 columns x 32 bits.

Read/Write to the SGRAM are burst oriented; accesses start at a selected location and continue for a programmed number of locations. By having a Programmable Mode Register, and Load Special Mode Register the system can choose Read or Write burst lengths of 1, 2, 4, or 8 locations or the Full Page with burst termination option.

An Auto Precharge function may be enabled to provide a self-timed precharge that is initiated at the end of the burst sequence.

The SGRAM uses an internal pipelined architecture to achieve high speed operation, which also allows the column address to be changed on every clock cycle to achieve a high-speed fully random access. Precharging one bank while accessing the alternate

bank will hide the precharge cycles, and provide seamless high speed random operation.

The SGRAM differs from the Synchronous DRAM (SDRAM) by providing an 8 column Block Write function and a Write-per-Bit (WPB) function. The Block Write and WPB functions may be combined with individual byte enables $\text{DQM}_0\text{-DQM}_3$.

The part is designed to operate at 3.3V only. An Auto Refresh mode is provided along with a power saving Power Down mode. All inputs and outputs are LVTTL compatible.

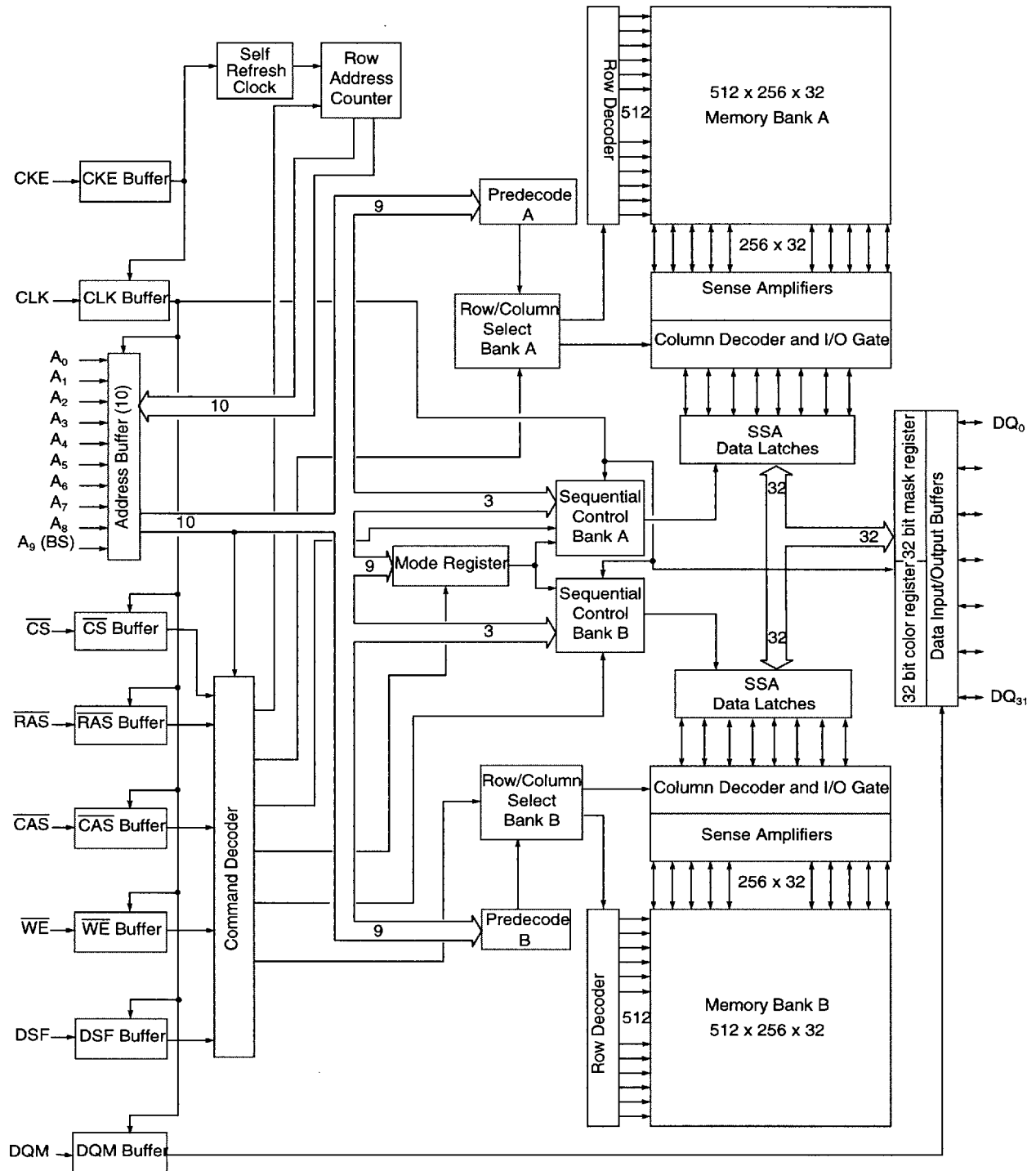
Applications

- Frame buffer for PC graphics applications
- One high speed device to displace two 256K x16 DRAMs
- High speed buffer for laser printers
- High speed buffer for RAID systems and disk drives
- Network and communication applications
- SET-TOP box application

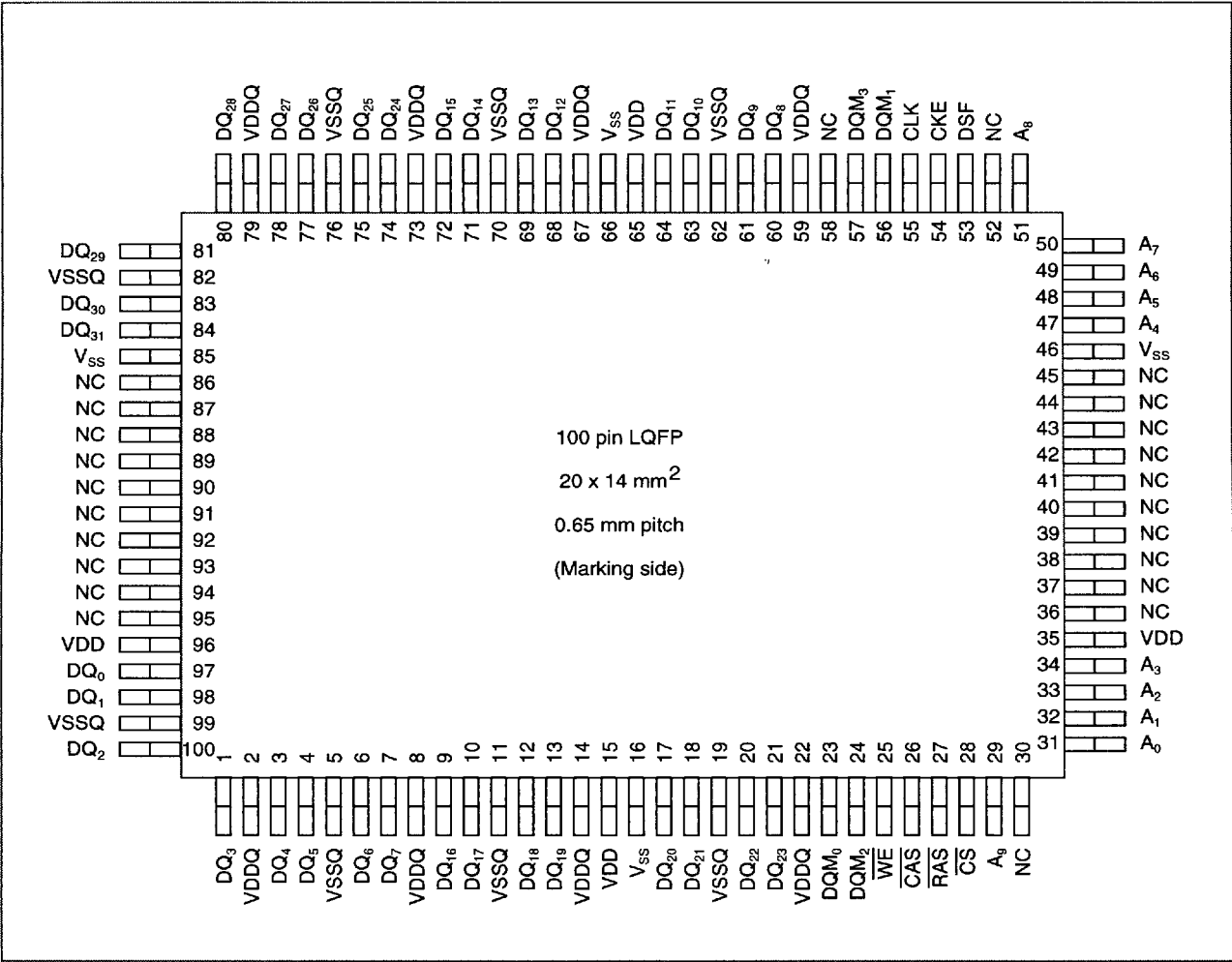
Ordering Information

| Part Number | Features | Speed | Voltage | Package | Notes |
|--|-----------------------------------|-------|---------|--|-------|
| IBM038329NQ6A - 10 | 100 MHz, 4 \overline{BE} , sync | 10 | 3.3V | 20X14 mm ² 100-pin LQFP (0.65min lead pitch) | 1 |
| IBM038329NQ6A - 12 | 83 MHz, 4 \overline{BE} , sync | 12 | | | 1 |
| IBM038329NQ6A - 15 | 66 MHz, 4 \overline{BE} , sync | 15 | | | 1 |
| IBM038329PQ6A - 10 | 100 MHz, 4 \overline{BE} , sync | 10 | | | 2 |
| IBM038329PQ6A - 12 | 83 MHz, 4 \overline{BE} , sync | 12 | | | 2 |
| IBM038329NQ6A - 15 | 66 MHz, 4 \overline{BE} , sync | 15 | | | 2 |
| 1. Low Power 8-Mb SGRAM parts. | | | | | |
| 2. Long Retention, extra low power 8-Mb SGRAM parts. | | | | | |

Block Diagram



Pin Configurations



| Symbol | Function |
|-----------------------------------|-----------------------|
| A ₀ -A ₉ | Address Inputs |
| A ₀ -A ₈ | Row Address Inputs |
| A ₀ -A ₇ | Column Address Inputs |
| A ₉ | Bank Select |
| $\overline{\text{CS}}$ | Chip Select |
| $\overline{\text{CAS}}$ | Column Address Strobe |
| CKE | Clock Enable |
| CLK | System Clock Input |
| DQ ₀ -DQ ₃₁ | Data Inputs/Outputs |

| Symbol | Function |
|------------------------------------|-------------------------|
| DQM ₀ -DQM ₃ | DQ Mask Enable |
| DSF | Special Function Enable |
| NC | No Connection |
| $\overline{\text{RAS}}$ | Row Address Strobe |
| VDD | Supply Voltage |
| V _{SS} | Ground |
| VDDQ | Supply Voltage for DQs |
| VSSQ | Ground for DQs |
| $\overline{\text{WE}}$ | Write Enable |

Signal Descriptions

| Name | I/O | Function |
|------------------------------------|-----|--|
| A ₀ -A ₉ | I | Address bits A ₀ -A ₈ are row addresses when Active command is activated. Address bits A ₀ -A ₇ are column addresses when CAS is active. Address bit A ₈ , when CAS is active, enables/disables Auto Precharge. Address bit A ₉ selects which of the two memory banks is to be used. |
| CLK | I | CLK is driven by the system clock. All SGRAM input signals are sampled on the positive edge of CLK. The CLK also increments the internal burst counter and controls the output registers. |
| CKE | I | Clock Enable disables the clock internally, thus allowing data to remain on the output for several CLK cycles. Clock Enable is also used as part of the input command to specify self-refresh. |
| $\overline{\text{CS}}$ | I | Chip Select indicates that the command on the input lines is for this device. If $\overline{\text{CS}}$ is high, the input command(s) will be ignored. |
| $\overline{\text{CAS}}$ | I | $\overline{\text{CAS}}$ is part of the input command to the SGRAM. See truth table for details. |
| $\overline{\text{RAS}}$ | I | $\overline{\text{RAS}}$ is part of the input command to the SGRAM. See truth table for details. |
| DSF | I | DSF is part of the input command to the SGRAM. If DSF is low, SGRAM operates the same way as SDRAM. |
| WE | I | Write Enable is part of the input command. See truth table or details. |
| DQ ₀ -DQ ₃₁ | I/O | Data Input/Output lines transfer data between the memory array and the system bus. These are also input mask bits for Write-per-Bit. When Block Write is activated, DQs provide column address mask. |
| DQM ₀ -DQM ₃ | I | During Read, DQM=1 turns off the output buffers. During Write, DQM=1 prevents a write to the current memory location. DQM ₀ corresponds to the lowest byte (DQ ₀ -DQ ₇). DQM ₁ corresponds to DQ ₈₋₁₅ . DQM ₂ corresponds to DQ ₁₆₋₂₃ . DQM ₃ corresponds to DQ ₂₄₋₃₁ . |

Operative Command Table (Part 1 of 7)

| Current State | CS | RAS | CAS | WE | DSF | Add | Command | Action | Notes |
|---------------|----|-----|-----|----|-----|------------|------------|------------------------------|-------|
| Idle | H | X | X | X | X | X | INHBT | Nop or Power Down | 5 |
| | L | H | H | X | X | X | NOP or BST | Nop or Power Down | 5 |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | 3 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | 3 |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | |
| | L | L | H | H | L | BA, RA | ACT | Row Active: No I/O Mask | |
| | L | L | H | H | H | BA, RA | ACTM | Row Active: I/O Mask | |
| | L | L | H | L | X | BA, PA | PRE/PREAL | Nop | |
| | L | L | L | H | X | X | REF/SREF | Refresh or Self Refresh | 6 |
| | L | L | L | L | L | Op-Code | LMR | Mode Register Access | |
| | L | L | L | L | H | Op-Code | LSMR | Special Mode Register Access | |
| Row Active | H | X | X | X | X | X | INHBT | Nop | |
| | L | H | H | X | X | X | NOP or BST | Nop | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | Begin Read: Determine AP | 11 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | Begin Write: Determine AP | 11 |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | Block Write: Determine AP | |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | |
| | L | L | H | L | X | BA, PA | PRE/PREAL | Precharge | 8 |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | Special Mode Register Access | |

1. H:High level, L:Low level, X:High or low level (Don't care), V:Valid data input.
2. All entries assume that CKE was active (High level) during the preceding clock cycle.
3. Illegal to bank specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
5. If both are idle, and CKE is inactive (Low level), the device will enter Power Down Mode. All inputs buffers except CKE will be disabled.
6. If both banks are idle, and CKE is inactive (Low level), the device will enter Self Refresh Mode. All input buffer except CKE will be disabled.
7. Illegal if t_{RRD} is not satisfied.
8. Illegal if t_{RAS} is not satisfied.
9. Must satisfy burst interrupt condition.
10. Must mask preceding data which don't satisfy t_{DPL} .
11. Illegal if t_{RCD} is not satisfied.

RA = Row Address ($A_0 - A_8$)

BA = Bank Address (A_9)

PA = Prechare All (A_8)

NOP = No Operation Command

CA = Column Address ($A_0 - A_7$)

AP = Auto Precharge (A_8)

Operative Command Table (Part 2 of 7)

| Current State | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | Add | Command | Action | Notes |
|---------------|-----------------|------------------|------------------|-----------------|-----|------------|-----------|---|-------|
| Read | H | X | X | X | X | X | INHBT | Continue Burst to End -> Row Active | |
| | L | H | H | X | X | X | NOP | Continue Burst to End -> Row Active | |
| | L | H | H | L | X | X | BST | Burst Stop -> Row Active | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | Term Burst, New Read: Determine AP | 9 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | Term Burst, Start Write: Determine AP | 4, 9 |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | Term Burst, Start Block Write: Determine AP | 4, 9 |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | Term Burst, Precharging | |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | Special Mode Register Access | |

1. H:High level, L:Low level, X:High or low level (Don't care), V:Valid data input.
2. All entries assume that CKE was active (High level) during the preceding clock cycle.
3. Illegal to bank specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
5. If both are idle, and CKE is inactive (Low level), the device will enter Power Down Mode. All inputs buffers except CKE will be disabled.
6. If both banks are idle, and CKE is inactive (Low level), the device will enter Self Refresh Mode. All input buffer except CKE will be disabled.
7. Illegal if t_{RHD} is not satisfied.
8. Illegal if t_{RAS} is not satisfied.
9. Must satisfy burst interrupt condition.
10. Must mask preceding data which don't satisfy t_{DPL} .
11. Illegal if t_{PCD} is not satisfied.

RA = Row Address ($A_0 - A_8$)

BA = Bank Address (A_9)

PA = Prechare All (A_8)

NOP = No Operation Command

CA = Column Address ($A_0 - A_7$)

AP = Auto Precharge (A_8)

Operative Command Table (Part 3 of 7)

| Current State | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | Add | Command | Action | Notes |
|---------------|-----------------|------------------|------------------|-----------------|-----|------------|-----------|---|-------|
| Write | H | X | X | X | X | X | INHBT | Continue Burst to End -> Row Active | |
| | L | H | H | X | X | X | NOP | Continue Burst to End -> Row Active | |
| | L | H | H | L | X | X | BST | Burst Stop -> Row Active | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | Term Burst, New Read: Determine AP | 9 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | Term Burst, Start Write: Determine AP | 4, 9 |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | Term Burst, Start Block Write: Determine AP | 4, 9 |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | Term Burst, Precharging | 10 |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | Special Mode Register Access | |

1. H:High level, L:Low level, X:High or low level (Don't care), V:Valid data input.
2. All entries assume that CKE was active (High level) during the preceding clock cycle.
3. Illegal to bank specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
5. If both are idle, and CKE is inactive (Low level), the device will enter Power Down Mode. All inputs buffers except CKE will be disabled.
6. If both banks are idle, and CKE is inactive (Low level), the device will enter Self Refresh Mode. All input buffer except CKE will be disabled.
7. Illegal if t_{RRD} is not satisfied.
8. Illegal if t_{RAS} is not satisfied.
9. Must satisfy burst interrupt condition.
10. Must mask preceding data which don't satisfy t_{DPL} .
11. Illegal if t_{PCD} is not satisfied.

RA = Row Address ($A_0 - A_8$)

BA = Bank Address (A_9)

PA = Prechare All (A_8)

NOP = No Operation Command

CA = Column Address ($A_0 - A_7$)

AP = Auto Precharge (A_8)

Operative Command Table (Part 4 of 7)

| Current State | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | Add | Command | Action | Notes |
|----------------------------|-----------------|------------------|------------------|-----------------|-----|------------|-----------|--------------------------------------|-------|
| Read with Auto Pre-charge | H | X | X | X | X | X | INHBT | Continue Burst to End -> Precharging | |
| | L | H | H | X | X | X | NOP | Continue Burst to End -> Precharging | |
| | L | H | H | L | X | X | BST | ILLEGAL | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | ILLEGAL | 3 |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | 3 |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | ILLEGAL | |
| Write with Auto Pre-charge | H | X | X | X | X | X | INHBT | Continue Burst to End -> Precharging | |
| | L | H | H | X | X | X | NOP | Continue Burst to End -> Precharging | |
| | L | H | H | L | X | X | BST | ILLEGAL | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | ILLEGAL | 3 |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | 3 |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | ILLEGAL | |

1. H:High level, L:Low level, X:High or low level (Don't care), V:Valid data input.
2. All entries assume that CKE was active (High level) during the preceding clock cycle.
3. Illegal to bank specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
5. If both are idle, and CKE is inactive (Low level), the device will enter Power Down Mode. All inputs buffers except CKE will be disabled.
6. If both banks are idle, and CKE is inactive (Low level), the device will enter Self Refresh Mode. All input buffer except CKE will be disabled.
7. Illegal if t_{RD} is not satisfied.
8. Illegal if t_{RAS} is not satisfied.
9. Must satisfy burst interrupt condition.
10. Must mask preceding data which don't satisfy t_{DPL} .
11. Illegal if t_{RCD} is not satisfied.

RA = Row Address ($A_0 - A_9$)

BA = Bank Address (A_9)

PA = Prechare All (A_9)

NOP = No Operation Command

CA = Column Address ($A_0 - A_7$)

AP = Auto Precharge (A_8)

Operative Command Table (Part 5 of 7)

| Current State | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | Add | Command | Action | Notes |
|----------------|-----------------|------------------|------------------|-----------------|-----|------------|-----------|---|-------|
| Precharging | H | X | X | X | X | X | INHBT | Nop -> Enter Idle after t_{RP} | |
| | L | H | H | X | X | X | NOP | Nop -> Enter Idle after t_{RP} | |
| | L | H | H | L | X | X | BST | Nop -> Enter Idle after t_{RP} | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | 3 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | 3 |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | 3 |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | Nop -> Enter Idle after t_{RP} | |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | ILLEGAL | |
| Row Activating | H | X | X | X | X | X | INHBT | Nop -> Enter Row Active after t_{RCD} | |
| | L | H | H | X | X | X | NOP | Nop -> Enter Row Active after t_{RCD} | |
| | L | H | H | L | X | X | BST | Nop -> Enter Row Active after t_{RCD} | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | 3 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | 3 |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | 3 |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3, 7 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3, 7 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | ILLEGAL | 3 |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | ILLEGAL | |

1. H:High level, L:Low level, X:High or low level (Don't care), V:Valid data input.
2. All entries assume that CKE was active (High level) during the preceding clock cycle.
3. Illegal to bank specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
5. If both are idle, and CKE is inactive (Low level), the device will enter Power Down Mode. All inputs buffers except CKE will be disabled.
6. If both banks are idle, and CKE is inactive (Low level), the device will enter Self Refresh Mode. All input buffer except CKE will be disabled.
7. Illegal if t_{RBD} is not satisfied.
8. Illegal if t_{RAS} is not satisfied.
9. Must satisfy burst interrupt condition.
10. Must mask preceding data which don't satisfy t_{DPL} .
11. Illegal if t_{RCD} is not satisfied.

RA = Row Address ($A_0 - A_8$)
 NOP = No Operation Command

BA = Bank Address (A_9)
 CA = Column Address ($A_0 - A_7$)

PA = Prechare All (A_8)
 AP = Auto Precharge (A_8)

Operative Command Table (Part 6 of 7)

| Current State | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | Add | Command | Action | Notes |
|--------------------------------------|-----------------|------------------|------------------|-----------------|-----|------------|-----------|--|-------|
| Write Recovering | H | X | X | X | X | X | INHBT | Nop -> Enter Row Active after t_{WR} | |
| | L | H | H | X | X | X | NOP | Nop -> Enter Row Active after t_{WR} | |
| | L | H | H | L | X | X | BST | Nop -> Enter Row Active after t_{WR} | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | Start Read, Determine AP | 4 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | New Write, Determine AP | |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | New Block Write, Determine AP | |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | ILLEGAL | 3 |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | Load Special Mask Register | |
| Write Recovering with Auto Precharge | H | X | X | X | X | X | INHBT | Nop -> Enter Precharge after t_{WR} | |
| | L | H | H | X | X | X | NOP | Nop -> Enter Precharge after t_{WR} | |
| | L | H | H | L | X | X | BST | Nop -> Enter Precharge after t_{WR} | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | 3, 4 |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | 3 |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | 3 |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | 3 |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | 3 |
| | L | L | H | L | X | BA, PA | PRE/PREAL | ILLEGAL | 3 |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | ILLEGAL | |

1. H:High level, L:Low level, X:High or low level (Don't care), V:Valid data input.
2. All entries assume that CKE was active (High level) during the preceding clock cycle.
3. Illegal to bank specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
5. If both are idle, and CKE is inactive (Low level), the device will enter Power Down Mode. All inputs buffers except CKE will be disabled.
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7. Illegal if t_{RD} is not satisfied.
8. Illegal if t_{RAS} is not satisfied.
9. Must satisfy burst interrupt condition.
10. Must mask preceding data which don't satisfy t_{DPL} .
11. Illegal if t_{RCD} is not satisfied.

RA = Row Address ($A_0 - A_9$)

BA = Bank Address (A_9)

PA = Prechare All (A_9)

NOP = No Operation Command

CA = Column Address ($A_0 - A_7$)

AP = Auto Precharge (A_8)

Operative Command Table (Part 7 of 7)

| Current State | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | Add | Command | Action | Notes |
|-------------------------|-----------------|------------------|------------------|-----------------|-----|------------|-----------|----------------------------------|-------|
| Refreshing | H | X | X | X | X | X | INHBT | Nop -> Enter Idle after t_{RC} | |
| | L | H | H | X | X | X | NOP | Nop -> Enter Idle after t_{RC} | |
| | L | H | H | L | X | X | BST | Nop -> Enter Idle after t_{RC} | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | |
| | L | L | H | L | X | BA, PA | PRE/PREAL | ILLEGAL | |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | OP-CODE | LSMR | ILLEGAL | |
| Mode Register Accessing | H | X | X | X | X | X | INHBT | Nop -> Enter Idle after 2Clocks | |
| | L | H | H | X | X | X | NOP | Nop -> Enter Idle after 2Clocks | |
| | L | H | H | L | X | X | BST | Nop -> Enter Idle after 2Clocks | |
| | L | H | L | H | X | BA, CA, AP | RD/RDA | ILLEGAL | |
| | L | H | L | L | L | BA, CA, AP | WR/WRA | ILLEGAL | |
| | L | H | L | L | H | BA, CA, AP | BW/BWA | ILLEGAL | |
| | L | L | H | H | L | BA, RA | ACT | ILLEGAL | |
| | L | L | H | H | H | BA, RA | ACTM | ILLEGAL | |
| | L | L | H | L | X | BA, PA | PRE/PREAL | ILLEGAL | |
| | L | L | L | H | X | X | REF/SREF | ILLEGAL | |
| | L | L | L | L | L | Op-Code | LMR | ILLEGAL | |
| | L | L | L | L | H | Op-Code | LSMR | ILLEGAL | |

1. H:High level, L:Low level, X:High or low level (Don't care), V:Valid data input.
2. All entries assume that CKE was active (High level) during the preceding clock cycle.
3. Illegal to bank specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
4. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
5. If both are idle, and CKE is inactive (Low level), the device will enter Power Down Mode. All inputs buffers except CKE will be disabled.
6. If both banks are idle, and CKE is inactive (Low level), the device will enter Self Refresh Mode. All input buffer except CKE will be disabled.
7. Illegal if t_{RRD} is not satisfied.
8. Illegal if t_{RAS} is not satisfied.
9. Must satisfy burst interrupt condition.
10. Must mask preceding data which don't satisfy t_{DPL} .
11. Illegal if t_{RCD} is not satisfied.

RA = Row Address ($A_0 - A_9$)

BA = Bank Address (A_9)

PA = Prechare All (A_9)

NOP = No Operation Command

CA = Column Address ($A_0 - A_7$)

AP = Auto Precharge (A_8)

Function Truth Table

| Operation | CKE | | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A_9 | A_8 | A_7-A_0 | MNE |
|-------------------------------|-----|---|-----------------|------------------|------------------|-----------------|-----|-----|---------|----------|-----------|----------|
| | n-1 | n | | | | | | | | | | |
| Device Deselect | H | X | H | X | X | X | X | X | X | X | X | INHBT |
| No Operation | H | X | L | H | H | H | X | X | X | X | X | NOP |
| Load Mode Register | H | X | L | L | L | L | L | X | OP CODE | | | LMR |
| Load Special Mode Register | H | X | L | L | L | L | H | X | OP CODE | | | LSMR |
| Row Activate | H | X | L | L | H | H | L | X | BS | Row Addr | | ACT |
| Row Activate w/WPB | H | X | L | L | H | H | H | X | BS | Row Addr | | ACTM |
| Read | H | X | L | H | L | H | X | X | BS | L | Col. | RD |
| Read w/ Auto Percharge | H | X | L | H | L | H | X | X | BS | H | Col. | RDA |
| Write Command | H | X | L | H | L | L | L | X | BS | L | Col. | WR |
| Write w/ Auto Precharge | H | X | L | H | L | L | L | X | BS | H | Col. | WRA |
| Block Write | H | X | L | H | L | L | H | X | BS | L | Col. | BW |
| Block Write w/ Auto Precharge | H | X | L | H | L | L | H | X | BS | H | Col. | BWA |
| Burst Termination | H | X | L | H | H | L | X | X | X | X | X | BST |
| Precharge Single Bank | H | X | L | L | H | L | X | X | BS | L | X | PRE |
| Precharge All Banks | H | X | L | L | H | L | X | X | X | H | X | PREAL |
| Auto Refresh | H | H | L | L | L | H | X | X | X | X | X | REF |
| Self Refresh Entry | H | L | L | L | L | H | X | X | X | X | X | SREF(EN) |
| Self Refresh Exit | L | H | H | X | X | X | X | X | X | X | X | SREF(EX) |
| Power Down Mode (entry) | H | L | H | X | X | X | X | X | X | X | X | PDN-(EN) |
| Power Down Mode (entry) | H | L | L | H | H | H | X | X | X | X | X | PDN-(EN) |
| Power Down Mode (exit) | L | H | X | X | X | X | X | X | X | X | X | PDN-(EX) |

1. All inputs are latched on the rising edge of the CLK.
2. LMR, LSMR, REF, and SREF commands should be issued only after both banks are deactivated (PREAL command).
3. ACT and ACTM command should be issued only after the corresponding bank has been deactivated (PRE command).
4. WR, WRA, RD, RDA should be issued after the corresponding bank has been activated (ACT command).
5. Auto Precharge command is not valid for full-page burst.
6. BW and BWA commands use mask register data only after ACTM command. DQM byte masking is active regardless of WPB mask.
7. Loading Mask Register: Initiate an LSMR cycle with address pin $A_5=1$ to load the Mask register with the Mask data present on DQ pins. Except A_5 , all other address pins must be "0" during LSMR cycle while loading the Mask Register.
8. Loading Color Register: Initiate an LSMR cycle with address pin $A_6=1$ to load the Color register with the Color input data on DQ pins. Except A_6 , all other address pins must be "0" during LSMR cycle while loading the Color register 0.
9. Any Write or Block Write cycles to the selected bank/row while active will be masked according to the contents of the mask register, in addition to the DQM signals and the column/byte mask information (the later for Block Writes only).
10. Block Writes are not burst oriented and always apply to the eight column locations selected by A_7-A_3 .

Functional Description

IBM's 8Mb SGRAM is a dual bank 128K x 32 SDRAM with graphics features of Block Write and Masked Write. It consists of two banks. Each bank is organized as 512 rows x 256 columns x 32 bits.

Read and Write accesses are burst oriented. Accesses begin with the registration of an Active command which is then followed by a Read or Write command. The address bits registered coincident with the Active command are used to select the bank and the row to be accessed. Address bit A_9 selects the bank and address bits A_8-A_0 select the row. Address bits A_7-A_0 registered coincident with the Read and Write command are used to select the starting column location for the burst access.

Block Writes are not burst oriented and always apply to eight column locations selected by A_7-A_3 . DQs registered at Write command are used to mask the selected columns. DQs registered coincident with the Active command are used as Write-per-Bit mask. DQs registered coincident with the Load Special Mode Register command are used as Color data (LC bit = 1) or Persistent Mask (LM = 1). If LC and LM are both 1 in the same Load Special Mode Register command cycle, the data of the Mask and the Color Register will be unknown.

Initialization

SGRAMs must be initialized in a predefined manner to prevent undefined operation. Once power is applied, the SGRAM requires a 100 μ s delay prior to activating CKE. All inputs should be held high during this phase of power up. After a delay of 100 μ s or more, the CKE pin must be driven high before a positive clock (CLK) edge. The first command will be registered on the clock edge following t_{CKS} .

Both banks must then be pre-charged by issuing PREAL command, thereby placing the device in the "all banks idle" state. Once in the idle state, at least two Auto Refresh cycles must be performed. Once the Auto Refresh cycles are complete, the SGRAM is ready for Mode Register programming. Because the Mode Register will power up in an unknown state, it should be programmed prior to performing any operational command.

Register Definition

The following pages describe the Mode Register and Special Mode Register functions.

Mode Register

The Mode Register is used to define: a Burst Length, a Burst type, a Read Latency and an operating mode as shown in the diagram on page 125. The mode register is programmed via the Load Mode Register command and will retain the stored information until it is programmed again or the device loses power. The mode register must be loaded when both banks are idle and the controller must wait the specified time before initiating the subsequent command. Violating either of these requirements may result in unknown operation.

Burst Length

Read and Write operations to the SGRAM are burst oriented, with the burst length being programmable, as shown in the diagram on page 125. The burst length determines the maximum number of column locations that can be accessed for a given Read or Write command. Burst lengths of 1, 2, 4, or 8 locations are available for both the sequential and the interleaved burst types and a Full Page Burst is available for the sequential type. The Full Page Burst is used in conjunction with the Burst Terminate command to generate arbitrary burst lengths.

When a Read or Write command is issued, a block of columns equal to the burst length is selected. The block is defined by address bits A_7-A_1 when the burst length is set to 2, by A_7-A_2 for burst length is set to 4 and by A_7-A_3 when the burst length is set to 8. The lower order bit(s) are used to select the starting location within the block. The burst will wrap within the block if a boundary is reached.

Burst Type

Accesses within a given burst may be programmed to be either sequential or interleaved and the type is selected based on the setting of WT bit in the mode register. If WT is set to "0", the burst type is sequential, if WT is "1", the burst type is interleave.

Read Latency

The Read Latency is the delay in clock cycles between the registration of a Read command and the availability of the first piece of output data. The latency can be set to 1, 2 or 3 clocks. If a Read command is registered at clock edge n and the Read Latency is 2 clocks, the data will be available by clock edge $n+2$. The DQs will start driving as a result of the clock edge one cycle earlier ($n+1$) and provided the relevant access times are met, the data will be valid by clock edge $n+2$.

Operation Mode

In normal operation, the M_7 - M_9 bits of Mode Register (MR) are set "0". The programmed burst length applies to both read and write bursts. If Bit M_7 is set equal to "1", two Color Registers are specified. Test modes and reserved states should not be used because unknown operation or incompatibility with future versions may result.

Load Special Mode Register (LSMR)

The Special Mode Register command is used to load the mask and color registers, which are used in Block Write and Masked Write cycles. The data to be written to either the color registers or the Mask Register is applied to the DQs and the control information is applied to the address inputs. During a LSMR cycle, if the address bit A_6 is "1", and all other address inputs are "0", the Color Register 0 will be loaded with the data on the DQs. If the address bits A_6 and A_7 are both set equal to "1" and Mode Register M_7 bit was already set equal to "1", Color Register 1 will be loaded with the data on the DQs. This color data is used for Block Write cycles. Similarly, when input A_5 is "1", and all other address inputs are "0" during a LSMR cycle, the mask register will be loaded with the data on the DQs.

Caution:

Never Set bit A_5 to "1" when A_6 and/or A_7 are set equal to "1" in the same Load Special Mode Register cycle to avoid unknown operation.

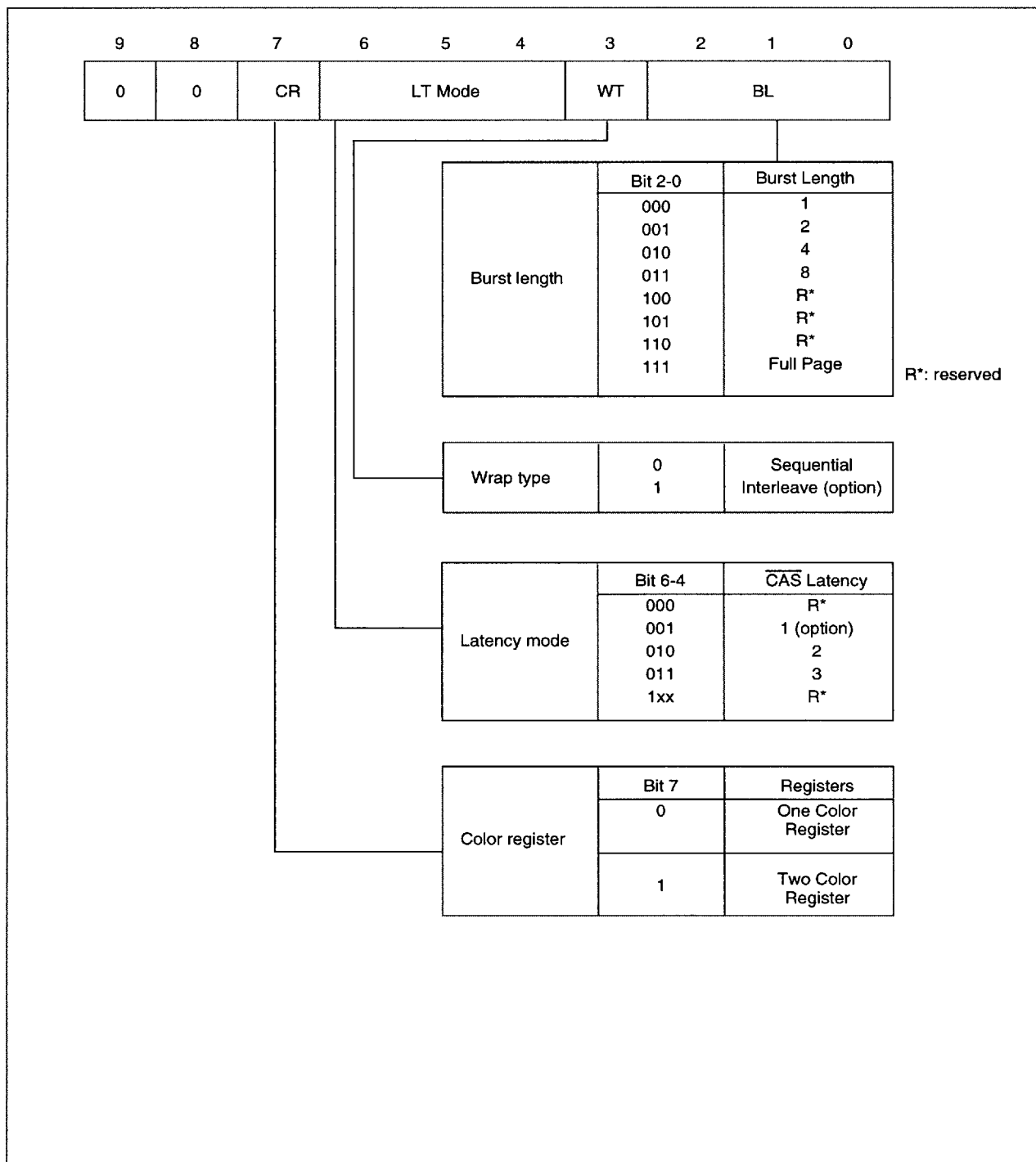
Color Registers

Two Color Registers (Color Register 0 and Color Register 1) are available in the devices as shown in the diagram on page 125. Each color register is a 32-bit register which supplies the data during Block Write cycles. The Color Register is loaded via a Load Special Mode Register command, as shown in the table on page 127 and will retain data until loaded again with a new data or until power is removed from the SGRAM.

Mask Register

The Mask Register (or the Write-per-Bit mask register) is a 32-bit register which acts as a per-bit mask during Masked Write and Masked Block Write cycles. The Mask Register is loaded via the Load Special Mode Register command and will retain data until loaded again or until power is removed from the SGRAM.

Mode Register Functions



Burst Length and Sequence

Burst of two

| Starting Address (Column Address A ₀) | Sequential Addressing Sequence (decimal) | Interleave Addressing Sequence (decimal) |
|---|--|--|
| 0 | 0,1 | 0,1 |
| 1 | 1,0 | 1,0 |

Burst of four

| Starting Address (Column Address A ₁ - A ₀) | Sequential Addressing Sequence (decimal) | Interleave Addressing Sequence (decimal) |
|--|--|--|
| 0 (00B) | 0,1,2,3 | 0,1,2,3 |
| 1 (01B) | 1,2,3,0 | 1,0,3,2 |
| 2 (10B) | 2,3,0,1 | 2,3,0,1 |
| 3 (11B) | 3,0,1,2 | 3,2,1,0 |

Burst of eight

| Starting Address (Column Address A ₁ - A ₀) | Sequential Addressing Sequence (decimal) | Interleave Addressing Sequence (decimal) |
|--|--|--|
| 0 (000B) | 0,1,2,3,4,5,6,7 | 0,1,2,3,4,5,6,7 |
| 1 (001B) | 1,2,3,4,5,6,7,0 | 1,0,3,2,5,4,7,6 |
| 2 (010B) | 2,3,4,5,6,7,0,1 | 2,3,0,1,6,7,4,5 |
| 3 (011B) | 3,4,5,6,7,0,1,2 | 3,2,1,0,7,6,5,4 |
| 4 (100B) | 4,5,6,7,0,1,2,3 | 4,5,6,7,0,1,2,3 |
| 5 (101B) | 5,6,7,0,1,2,3,4 | 5,6,7,6,1,0,3,2 |
| 6 (110B) | 6,7,0,1,2,3,4,5 | 6,7,4,5,2,3,0,1 |
| 7 (111B) | 7,0,1,2,3,4,5,6 | 7,6,5,4,3,2,1,0 |

Full Page Burst

Full Page Burst is an extension of the above tables of Sequential Addressing with the burst length being 256.



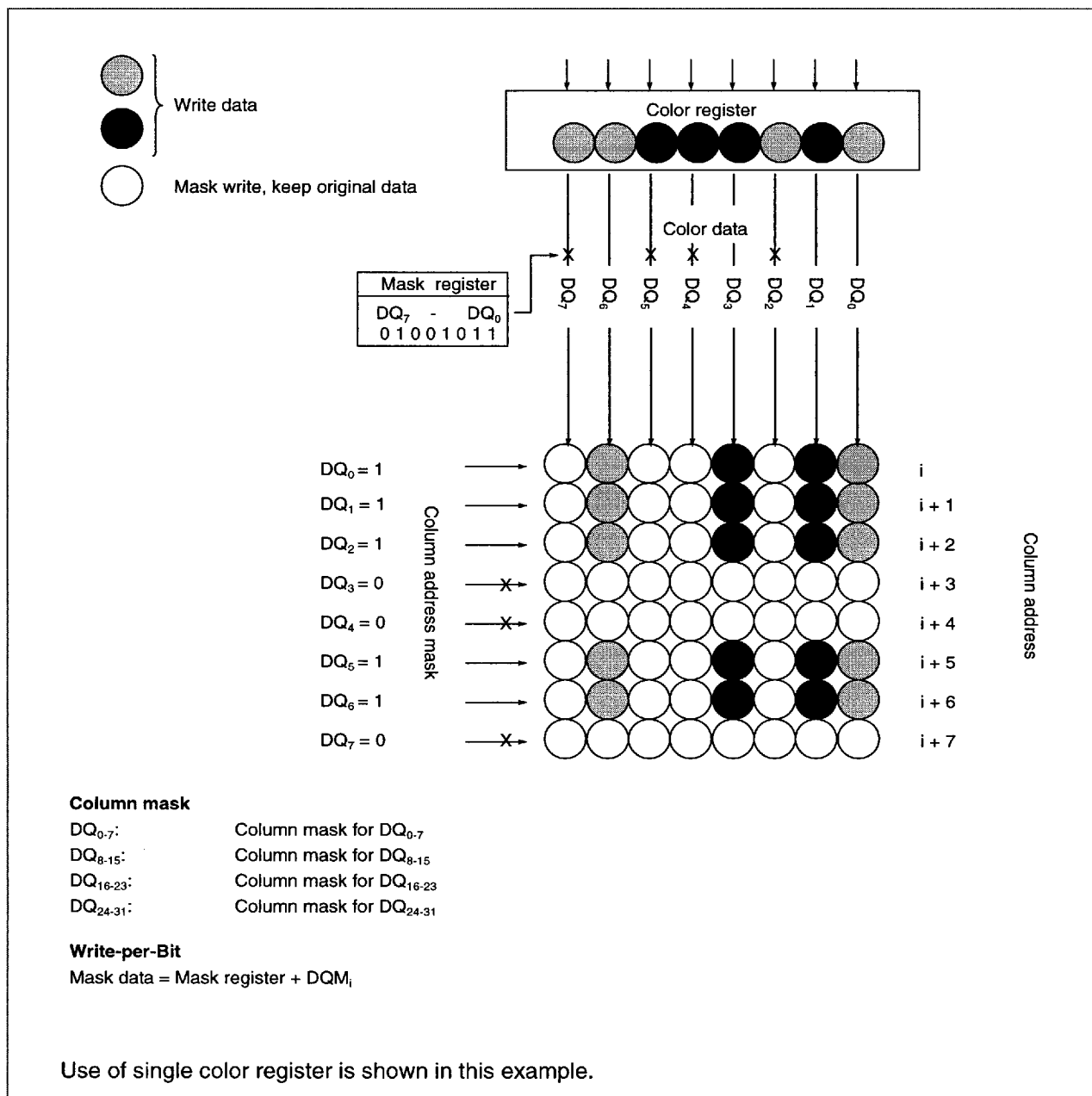
Advance

IBM038329PQ6
IBM038329NQ6
256K x 32 Synchronous Graphics RAM

Special Mode Register Functions

| Address Bits | | | | | | | | | | Functions |
|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|-----------------------|
| A ₉ | A ₈ | A ₇ | A ₆ | A ₅ | A ₄ | A ₃ | A ₂ | A ₁ | A ₀ | |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Do not load |
| 0 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | Enable Mask |
| 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | Load Color Register 0 |
| 0 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | Load Color Register 1 |

Block Write Illustration



Commands

The Function Truth Table on page 121 provides a quick reference of available commands.

Device Deselect (INHBT)

The device deselect or inhibit function prevents commands from being executed by the SGRAM, regardless of whether the CLK signal is enabled. The device is effectively deactivated (\overline{CS} is high).

No Operation (NOP)

The NOP command is used to perform a no operation to an SGRAM which is selected (\overline{CS} is low). This prevents unwanted commands being registered during idle or wait states. The execution of the command(s) already in progress will not be affected.

Load Mode Register (LMR)

The Mode Register is loaded via address input pins A_9-A_0 . **The LMR command can only be issued when both banks are idle, and a subsequent executable command can not be issued until t_{MTC} (2 CLK cycle Latency) is met.**

Load Special Mode Register (LSMR)

LSMR command is used to load either the Color Register or the Mask Register at a time. The control information is provided on inputs A_9-A_0 , while the data for the Color or Mask Register is provided on the DQs. The LSMR command can be issued when both banks are idle, or one or both are active but with no Read, Write or Block Write accesses in progress. **A subsequent command can not be issued until t_{SML} (2 clocks latency) is met.**

Active (ACT)

The ACT command is used to open (or activate) a row in a particular bank. The value on A_9 selects the bank and the address provided on input pins A_8-A_0 selects the row. This row remains open for accesses until a Precharge command is issued to the bank. **A Precharge command must be issued before opening a different row in the same bank.**

Active with WPB (ACTM)

ACTM command is similar to the ACT command, except that the Write-per-Bit mask is activated. Any Write or Block Write cycles to the selected bank/row while active will be masked according to the contents of the Mask Register.

Read (RD)

The Read command is used to initiate a burst read access from an active row. The value on A_9 selects the bank and the address provided on inputs A_7-A_0 selects the starting column location. The value on A_8 determines whether or not Auto Precharge is used. If A_8 is "1", Auto Precharge is used. If Auto Precharge is selected, the row being accessed will be precharged at the end of the read burst; if Auto Precharge is not selected, the row will remain open for subsequent accesses. **If a particular DQM was registered high, the corresponding DQs appearing 2 clocks later on the output pins will be High-Z.**

Write (WR)

The Write command is used to initiate a burst write access to an active row. The value on A_9 selects the bank and the address provided on inputs A_7 - A_0 selects the starting column location. The value on A_8 determines whether or not Auto Precharge is used. If A_8 is "1", Auto Precharge is used. If Auto Precharge is selected, the row being accessed will be precharged at the end of write burst; if Auto Precharge is not selected, the row will remain open for subsequent accesses. ***If a particular DQM is registered high, the corresponding data inputs will be ignored and the write will not be executed to that byte location.***

Block Write (BW)

The Block Write command is used to write a single data value to the block of eight consecutive column locations addressed by inputs A_7 - A_3 . The data is provided by the Color Register which must be loaded prior to the Block Write cycle by invoking LSMR cycle. The input data on DQs which is registered coincident with the Block Write command is used to mask specific column/byte combinations within the block. ***The DQM signals operate the same way as for Write cycles, but are applied to all eight columns in the selected block.***

Precharge (PRE)

The Precharge command is used to deactivate the open row in a particular bank or the open row in both banks. The bank(s) will be available for row access some specified time (t_{RP}) after the Precharge command is issued. Input A_8 determines whether one or both banks are to be precharged, input A_9 selects the bank. If A_8 is "1", both banks are to be precharged and A_9 is "don't care." Once a bank is precharged (or deactivated), it is in the idle state and must be activated prior to any Read, Write, or Block Write commands being issued to that bank.

Auto Precharge (PREA)

The Auto Precharge feature allows the user to issue a Read, Write, or Block Write command that automatically performs a precharge upon the completion of the Block Write access or Read or Write burst, ***except in the Full Page Burst mode, where it has no effect.***

The use of this feature eliminates the need to "manually" issue a Precharge command during the functional operation of the SGRAM.

Burst Terminate (BST)

The Burst Terminate command is used to truncate either fixed-length or Full Page Bursts.

Auto Refresh (REF)

Auto Refresh is used to refresh the various rows in the SGRAM and is analogous to $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ (CBR) in DRAMs. This command must be issued each time a refresh is required. The addressing is generated by the internal refresh counter, therefore, the address bits are "don't care" during a CBR cycle. The SGRAM requires that 1024 rows to be refreshed every 16ms (t_{REF}). This refresh can be accomplished either by providing a Auto Refresh command every 16.6 μ s or all 1024 Auto Refresh commands can be issued in a burst at the minimum cycle rate (t_{RC} = 100ns) once every 16ms.



Self Refresh (SREF)

The Self Refresh command can be used to retain data in the SGRAM, even if the rest of the system is powered down. When in the Self Refresh mode, the SGRAM retains data without external clocking. Once the SREF command is registered, all the inputs to the SGRAM become “don't care” with the exception of CKE, which must remain low. Once SREF mode is engaged, the SGRAM provides its own internal clocking, causing it to perform its own Auto Refresh cycles. The SGRAM may remain in Self Refresh mode for an indefinite period. The procedure for exiting requires a sequence of commands. First, the system clock must be stable prior to CKE going high. ***Once CKE is high, the SGRAM must have NOP commands issued for t_{XSR} (100ns), because of the time required for the completion of any bank currently being internally refreshed.***

Absolute Maximum Ratings

| Parameter | Min | Max | Notes |
|---|-------|-------|-------|
| Voltage on V_{CC}/V_{CCQ} supply relative to V_{SS} | -1V | 4.6V | 1 |
| Voltage on input/output pins | -1V | 4.6V | 1 |
| Operating Temperature, T_A (ambient) | 0°C | 70°C | 1 |
| Storage Temperature | -55°C | 150°C | 1 |
| Power Dissipation | | 1W | 1 |
| Short Circuit Output Current | | 50mA | 1 |

1. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Operating Specifications and Conditions ($0^\circ\text{C} \geq T_A \leq 70^\circ\text{C}$; $V_{CC}/V_{CCQ} = 3.3\text{V} \pm 0.3\text{V}$)

| Symbol | Parameter | Min | Typ | Max | Unit |
|------------------|---|------|-----|----------------|---------------|
| V_{CC}/V_{CCQ} | Supply Voltage | 3.0 | 3.3 | 3.6 | V |
| V_{IH} | Input High (Logic 1) Voltage, all inputs | 2.0 | - | $V_{CC} + 0.3$ | V |
| V_{IL} | Input Low (Logic 0) Voltage, all inputs | -0.5 | - | 0.8 | V |
| V_{OH} | Output High ($I_{OUT} = -2\text{mA}$) | 2.4 | - | - | V |
| V_{OL} | Output Low ($I_{OUT} = 2\text{mA}$) | - | - | 0.4 | V |
| I_L | Input Leakage Current Any Input $0\text{V} < V_{IN} < 3.6\text{V}$ (All other pins not under test = 0V) | -1 | - | 1 | μA |
| I_{OZ} | Output Leakage Current (DQs are disabled; $0\text{V} < V_{OUT} < 0.4\text{V}$) | -1 | - | 1 | μA |

Capacitance

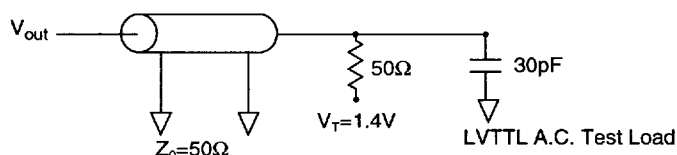
| Symbol | Parameter | Max | Unit | Notes |
|--|---|-----|------|-------|
| C_{i1} | Input Capacitance: $A_0 - A_9$ | 5 | pF | 1 |
| C_{i2} | Input Capacitance: $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, $\overline{\text{WE}}$, DQM, CLK, CKE, $\overline{\text{CS}}$, DSF | 5 | pF | 1 |
| C_{i0} | Input/Output Capacitance: DQs | 5 | pF | 1 |
| 1. This parameter is sampled. $V_{CC}/V_{CCQ} = 3.3\text{V} \pm 0.3\text{V}$; $f = 1\text{MHz}$, 15 mv sine wave | | | | |

I_{CC} Specifications (0°C ≤ T_A ≤ 70°C; V_{CC}/V_{CCQ} = 3.3V ± 0.3V)

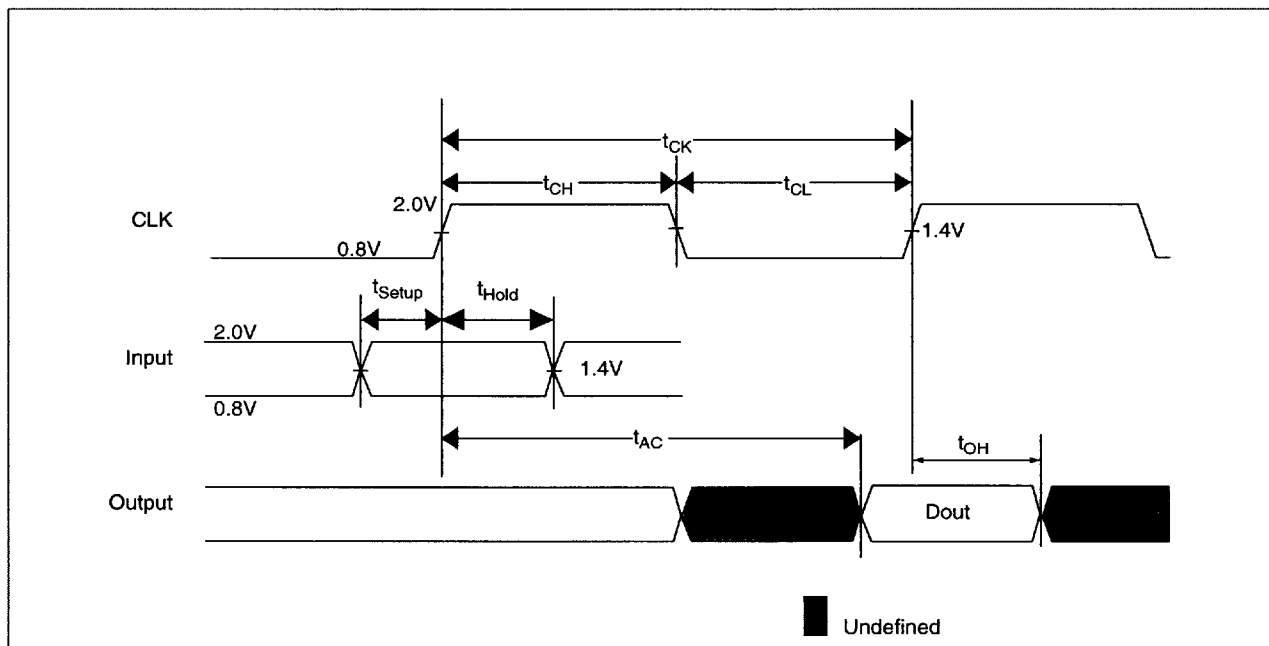
| Symbol | Parameter | Test Condition | $\overline{\text{CAS}}$ Latency | Maximum | | | Unit | Notes |
|---|--|--|------------------------------------|---------|-----|-----|------|-------|
| | | | | -10 | -12 | -15 | | |
| I _{CC1} | Operating Current | Burst Length = 1 t _{RC} ≥ t _{RC} (Min) t _{CK} ≥ t _{CK} (Min) I _O = 0mA | 3 | 140 | 135 | 140 | mA | 1 |
| | | | 2 | 130 | 125 | 130 | | |
| | | | 1 | 120 | 115 | 120 | | |
| I _{CC2P} | Precharge Standby Current in Power Down Mode | CKE ≤ VIL(Max) t _{CK} = 15ns | 3 | 3 | 3 | 3 | mA | |
| I _{CC2PS} | | CKE ≤ VIL(Max) t _{CK} = Infinity | 3 | 3 | 3 | 3 | | |
| I _{CC2N} | Precharge Standby Current in Non Power Down Mode | CKE ≥ VIH(Min) t _{CK} = 15ns Input change every 30ns | 20 | 20 | 20 | 20 | mA | |
| I _{CC2NS} | | CKE ≥ VIH(Min) t _{CK} = Infinity No input change | 9 | 9 | 9 | 9 | | |
| I _{CC3P} | Active Standby Current in Power Down Mode | CKE ≤ VIL(Max) t _{CK} = 15ns | 3 | 3 | 3 | 3 | mA | |
| I _{CC3PS} | | CKE ≤ VIL(Max) t _{CK} = Infinity | 2 | 2 | 2 | 2 | | |
| I _{CC3N} | Active Standby Current in Non Power Down Mode | CKE ≥ VIH(Min) t _{CK} = 15ns Input change every 30ns | 25 | 25 | 25 | 25 | mA | |
| I _{CC3NS} | | CKE ≥ VIH(Min) t _{CK} = Infinity No input change | 12 | 12 | 12 | 12 | | |
| I _{CC4} | Operating Current (Burst Mode) | t _{RC} = Infinity I _O = 0mA Dual Bank Interleave Continuous | 3 | TBD | TBD | TBD | mA | 1,2 |
| | | | 2 | TBD | TBD | TBD | | |
| | | | 1 | TBD | TBD | TBD | | |
| I _{CC5} | Auto Refresh Current | t _{RC} ≥ t _{RC} (Min) | 3 | 110 | 105 | 85 | mA | 3 |
| | | | 2 | 100 | 95 | 75 | | |
| | | | 1 | 90 | 85 | 65 | | |
| I _{CC6} | Self Refresh Current | CKE = 0.2V | 2 | 2 | 2 | 2 | mA | |
| 1. Measured with outputs open. 2. Assumes minimum column address update cycle. 3. Refresh period is 16ms. | | | | | | | | |

Timing Specifications and Conditions ($0^{\circ}\text{C} \leq t_A \leq 70^{\circ}\text{C}$; $V_{CC}/V_{CCQ} = 3.3\text{V} \pm 0.3\text{V}$)

1. All voltages are referenced to V_{SS} (GND).
2. I_{CC} depends on output loading and cycle rates. Specified values are obtained with minimum cycle time and the outputs open.
3. Enables on-chip refresh and address counters.
4. The minimum specifications are used only to indicate cycle time at which proper operation over the full temperature range ($0^{\circ}\text{C} \leq T_A \leq 70^{\circ}\text{C}$)
5. An initial pause of 100ms is required after power up, followed by two Auto Refresh commands to ensure proper device operation.
6. The timing specifications assume a transition time ($t_T = 1\text{ns}$).
7. AC timing tests have $V_{IL} = 0.8\text{V}$ and $V_{IH} = 2.0\text{V}$ with timing reference to 1.4V crossover point.



I/O Timing diagrams





Advance

IBM038329PQ6
IBM038329NQ6
256K x 32 Synchronous Graphics RAM

| Symbol | Parameter | CAS Latency | -10 | | -20 | | -30 | | Units |
|--------------------------|---|-------------|-----|--------------|-----|--------------|-----|--------------|----------|
| | | | Min | Max | Min | Max | Min | Max | |
| t_{AC3} for 50 pF load | Access time from CLK (positive edge) | 3 | - | 9 | - | 11 | - | 13 | ns |
| t_{AC2} for 80 pF load | | 2 | - | 12 | - | 15 | - | 18 | |
| t_{AC1} for 80 pF load | | 1 | - | 27 | - | 33 | - | 40 | |
| t_{AH} | Address hold time | | 1 | - | 1.5 | - | 2 | - | ns |
| t_{AS} | Address setup time | | 3 | - | 3.5 | - | 4 | - | ns |
| t_{BPL} | Block Write to Precharge delay | | 10 | - | 12 | - | 15 | - | ns |
| t_{BWC} | Block Write cycle time | | 10 | - | 12 | - | 15 | - | ns |
| t_{CH} | \overline{CS} , \overline{RAS} , \overline{CAS} , \overline{WE} , DSF, DQM hold time | | 1 | - | 1.5 | - | 2 | - | ns |
| t_{CHI} | CLK high level width | | 3.5 | - | 4 | - | 5 | - | ns |
| t_{CK3} | System clock cycle time | 3 | 10 | - | 12 | - | 15 | - | ns |
| t_{CK2} | | 2 | 15 | - | 18 | - | 23 | - | |
| t_{CK1} | | 1 | 30 | - | 36 | - | 45 | - | |
| t_{CKH} | CKE hold time | | 1 | - | 1.5 | - | 2 | - | ns |
| t_{CKS} | CKE setup time | | 3 | - | 3.5 | - | 4 | - | ns |
| t_{CL} | CLK low level width | | 3.5 | - | 4 | - | 5 | - | ns |
| t_{CS} | \overline{CS} , \overline{RAS} , \overline{CAS} , \overline{WE} , DSF, DQM setup time | | 3 | - | 3.5 | - | 4 | - | ns |
| t_{DH} | Data-in hold time | | 1 | - | 1.5 | - | 2 | - | ns |
| t_{DS} | Data-in setup time | | 3 | - | 3.5 | - | 4 | - | ns |
| t_{HZ} | Data-out high impedance time | | 4 | 10 | 4 | 10 | 4 | 10 | ns |
| t_{LZ} | Data-out low impedance time | | 3 | - | 3 | - | 3 | - | ns |
| t_{MTC} | Load Mode Register command to command | | 2 | - | 2 | - | 2 | - | t_{CK} |
| t_{OH} | Data-out hold time | | 4 | - | 4 | - | 4 | - | ns |
| t_{RAS} | Active to Precharge command period | | 60 | 120K | 72 | 120K | 90 | 120K | ns |
| t_{RC} | Auto Refresh and Active to Active command period | | 100 | - | 100 | - | 110 | - | ns |
| t_{RCD} | Active to Read, Write or Block Write delay | | 30 | - | 36 | - | 45 | - | ns |
| t_{REF} | Refresh Period (1024 cycles) for Non Self-Refresh parts | | - | 16 | - | 16 | - | 16 | ms |
| t_{REF} | Refresh Period (1024 cycles) for Self-Refresh parts | | - | 64, 128, 256 | - | 64, 128, 256 | - | 64, 128, 256 | ms |
| t_{RP} | Row Precharge time | | 30 | - | 36 | - | 45 | - | ns |
| t_{RRD} | Active bank A to Active bank B command period | | 30 | - | 36 | - | 45 | - | ns |
| t_{SML} | Load Special Mode Register command to command | | 2 | - | 2 | - | 2 | - | t_{CK} |
| t_T | Transition time | | 1 | 30 | 1 | 30 | 1 | 30 | ns |
| t_{WR} | Write recovery time | | 10 | - | 12 | - | 15 | - | ns |
| t_{XSR} | Exit Self Refresh to Active command | | 100 | - | 100 | - | 110 | - | ns |

Detailed Operation

Initialization and Load Mode Register

The SGRAM must be initialized at power up time to prevent undefined operations. The diagram on page 137 shows this process in detail. The next step is to load the mode register to program the burst length, and burst type. The Load Mode Register and Special Mode Register functions have been described earlier.

The initialization of the device and loading of the Mode Register is shown in the diagram on page 137. If the device is not initialized prior to issuing a command, it may result in an undefined operation. The Mode Register should be loaded to set burst type, length of burst, CAS Latency, Sequence and number of Color Registers to be used.

Auto Refresh (REF)

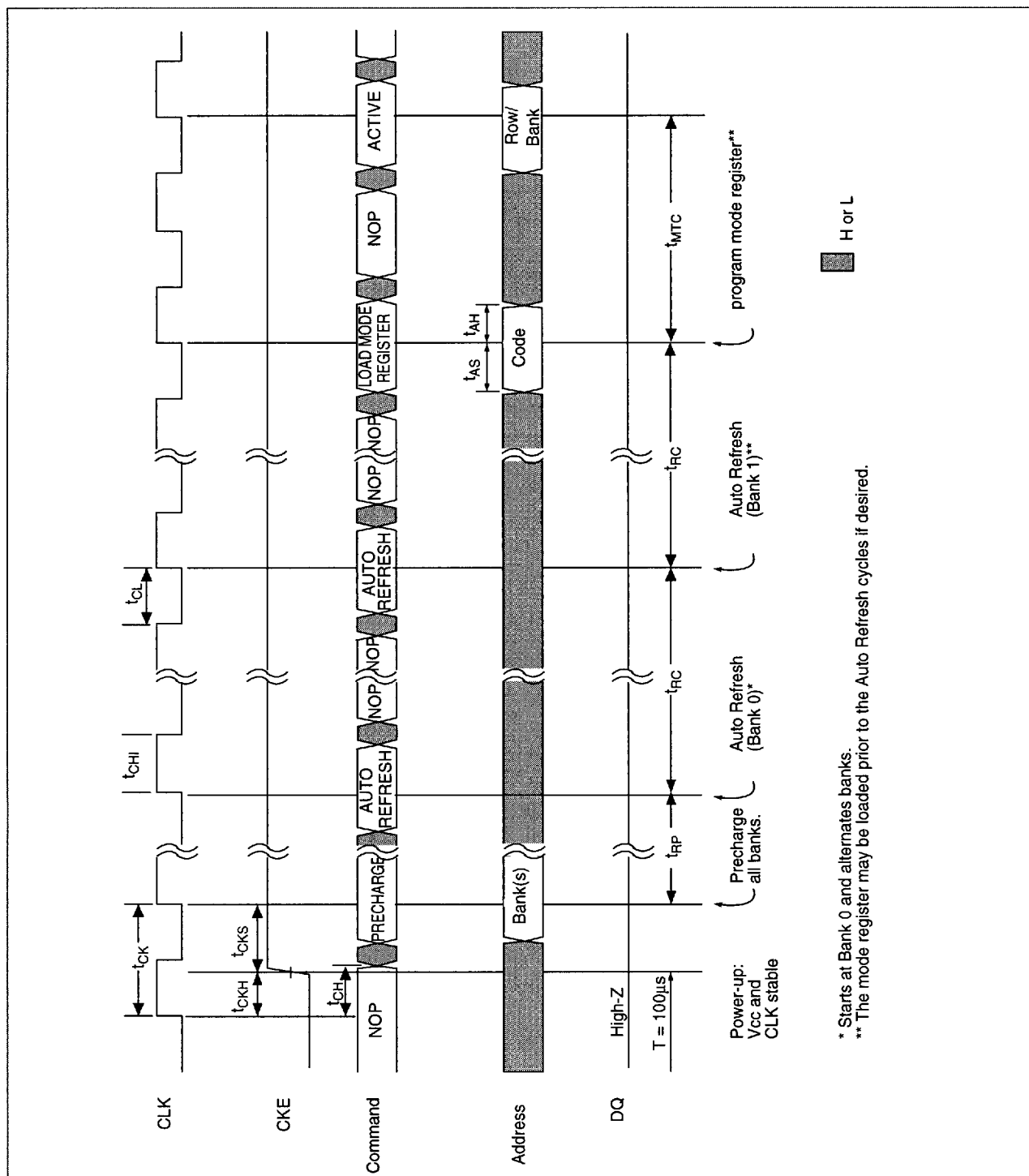
This mode is similar to CBR used in conventional DRAMs to refresh the DRAM rows.

This command is essential to refresh the volatile DRAM cells every 16ms. The device could be refreshed by issuing 1024 Auto Refresh cycles every 16ms or these refresh cycles could be interleaved between various operations as long as each DRAM cell is refreshed every 16ms or less.

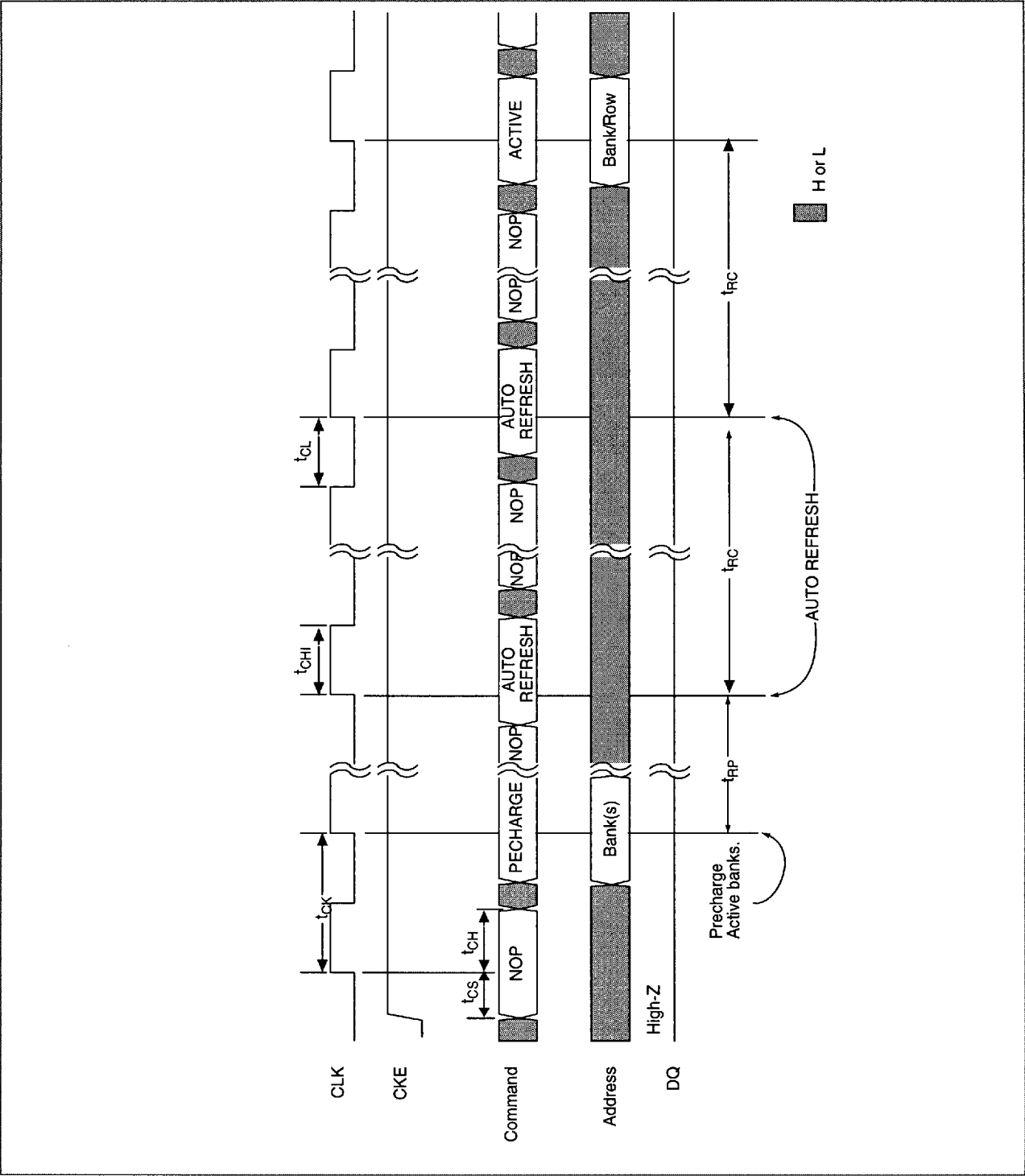
Logic Table for Auto Refresh Command Cycle

| Mnemonic | CKE | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A ₉ | A ₈ | A ₇ -A ₀ |
|----------|-----|-----------------|------------------|------------------|-----------------|-----|-----|----------------|----------------|--------------------------------|
| REF | H | L | L | L | H | L | X | X | X | X |

Initialize and Load Mode Register Operation.



Auto Refresh Mode



Bank/Row Activation Command (ACT)

Before any Read or Write commands can be issued to a bank within the SGRAM, a row in that bank must be "opened". An Active command is used for this purpose. The Active command is also used to determine whether or not the Write-per-Bit mask is to be applied during Write and Block Write cycles within that row.

A subsequent Active command to a different row in the same bank can only be issued after the previous Active row has been "closed". The minimum time interval between successive Active commands to the same bank is defined by t_{RC} .

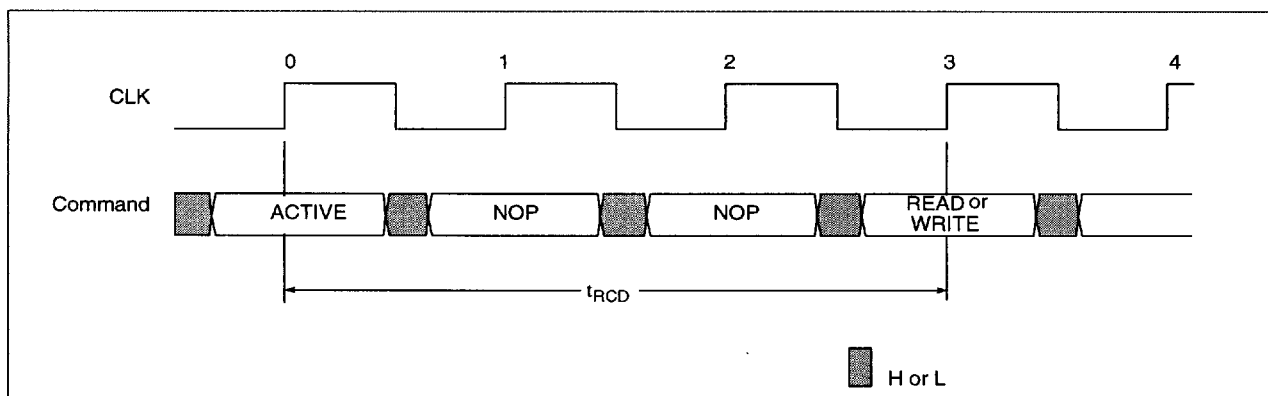
A subsequent Active command to the other bank can be issued while the first bank is being accessed, which results in a reduction of total row access overhead. The minimum time interval between successive Active commands to different banks is defined by t_{RRD} .

Logic Table for Active Command

| Mnemonic | CKE | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A ₉ | A ₈ | A ₇ -A ₀ |
|----------|-----|-----------------|------------------|------------------|-----------------|-----|-----|----------------|----------------|--------------------------------|
| ACT | H | L | L | H | H | L | X | BS | Row Address | |
| ACTM | H | L | L | H | H | H | X | BS | Row Address | |

The diagram on page 139 shows the Read/Write command delay in the same bank after the Active command has been registered. Also are shown the various timing parameters that are applicable to the Read/Write operations.

Example Meeting $t_{RCD} \text{ (min)}$ when $2 \leq t_{RCD} \text{ (min)}/t_{CK} \leq 3$



Read Command (RD)

The following pages describe in detail the Read operations with the help of timing diagrams for various cases.

Logic Table for Read Command

| Mnemonic | CKE | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A ₉ | A ₈ | A ₇ -A ₀ |
|----------|-----|-----------------|------------------|------------------|-----------------|-----|-----|----------------|----------------|--------------------------------|
| RD | H | L | H | L | H | L | 0/1 | BS | L | Column |
| RDA | H | L | H | L | H | L | 0/1 | BS | H | Column |

Read bursts are initiated with a Read command. The starting column address and the bank address are provided with the Read command and Auto Precharge is either enabled or disabled for that burst access. Upon completion of a burst, assuming no other commands have been initiated, the DQs will go High-Z. A Full Page Burst will continue until terminated (at the end of the page it will wrap to column 0 and continue).

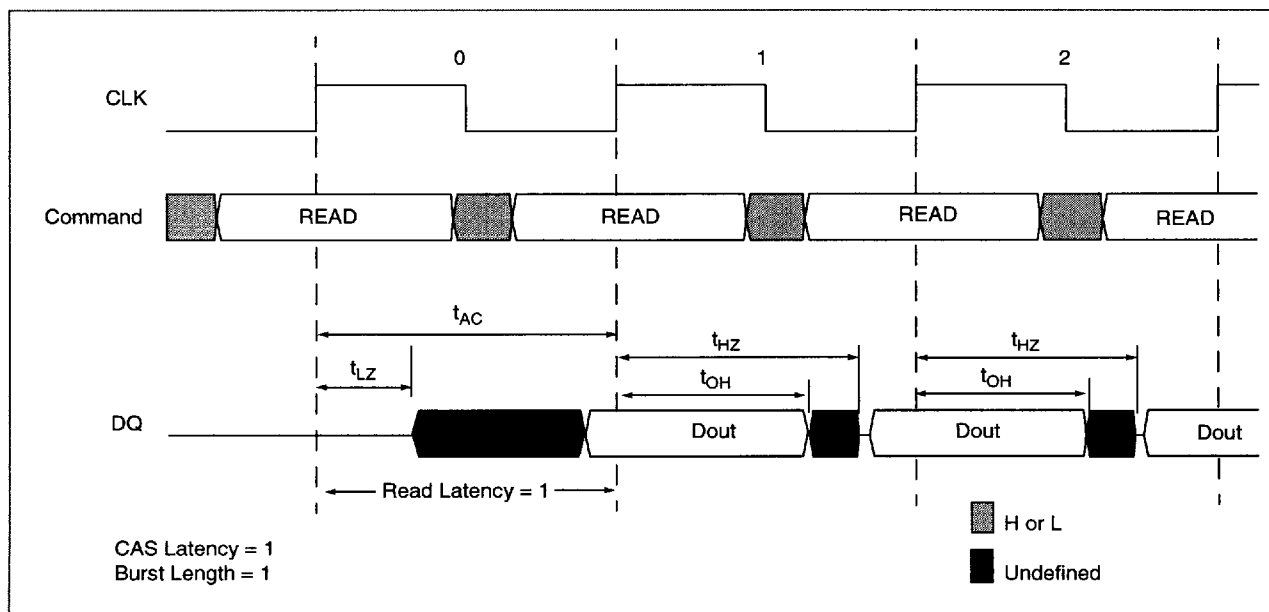
Various cases of Reads are shown. The user can use latency of one, two or three depending upon the system clock. A fixed-length Read Burst may be followed by or truncated with a Write burst or Block Write command (provided that Auto Precharge was not activated) and a Full Page Read burst may be truncated by a Write burst or Block Write command. The Write burst may be initiated on the clock edge immediately following the last (or last desired) data element from the Read burst, provided that I/O contention can be avoided. ***It is generally a good design practice that a single cycle delay must occur between the last data read and the Write command.***

The DQM inputs are used to avoid I/O contention as shown in the second diagram on page 145. The DQMs must be asserted High at least two clocks (DQM latency is two clocks for output buffers) prior to the Write command to suppress data-out due to the previous Read command. Once the Write command is registered, the output buffers will go High-Z (or remain High-Z) regardless of the state of DQM signals. The DQM signals must be de-asserted (DQM latency is zero clocks for input buffers) prior to the Write command to ensure that the written data is not masked. The first diagram on page 145 shows the case where the clock frequency allows for bus contention to be avoided without adding a NOP cycle, and the second diagram on page 145 shows the case where the additional NOP is needed.

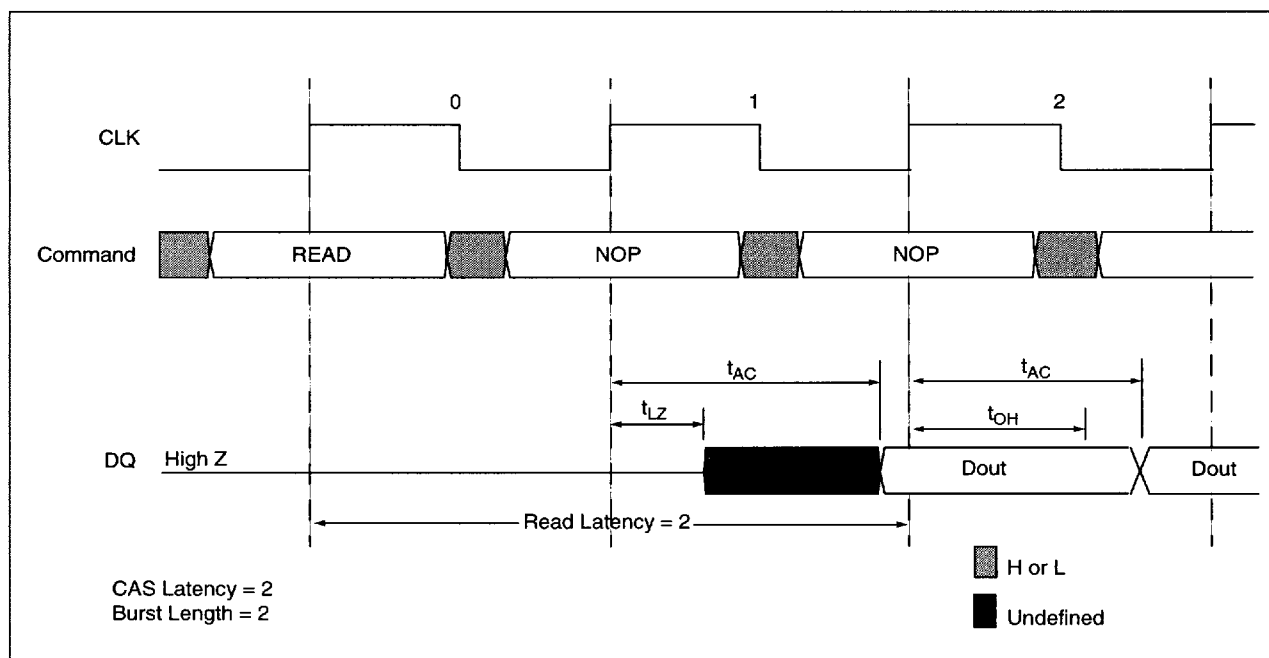
A fixed-length as well as a Full Page Read burst may be truncated with a Precharge command to the same bank. Note that the Precharge command should be issued one cycle before the clock edge at which the last desired data is valid. A subsequent command can not be issued to the same bank until t_{RP} is met. Part of the row precharge time is hidden during the access of the last data element. An Auto Precharge command can be used in place of Precharge command for fixed length bursts. The disadvantage of Auto Precharge command is that it does not truncate fixed-length bursts and does not apply to Full Page Bursts. The disadvantage of the Precharge is that it requires the command and address busses to be available at the appropriate time to issue the command.

The full-page, as well as fixed-length Read burst may be terminated with the Burst Terminate command. The fixed-length Burst with Auto Precharge can not be truncated by Burst Terminate command. ***The Burst Terminate command should be issued one cycle before the positive clock edge at which the last desired data element is valid.***

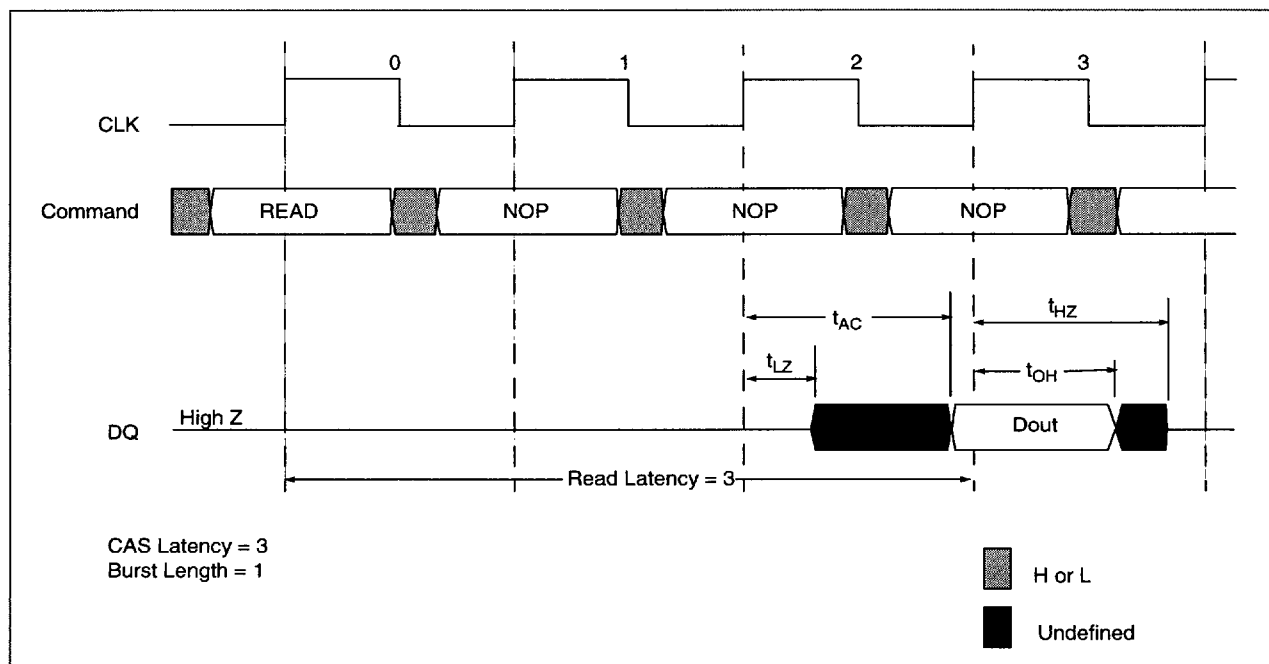
One Clock Read Latency Example



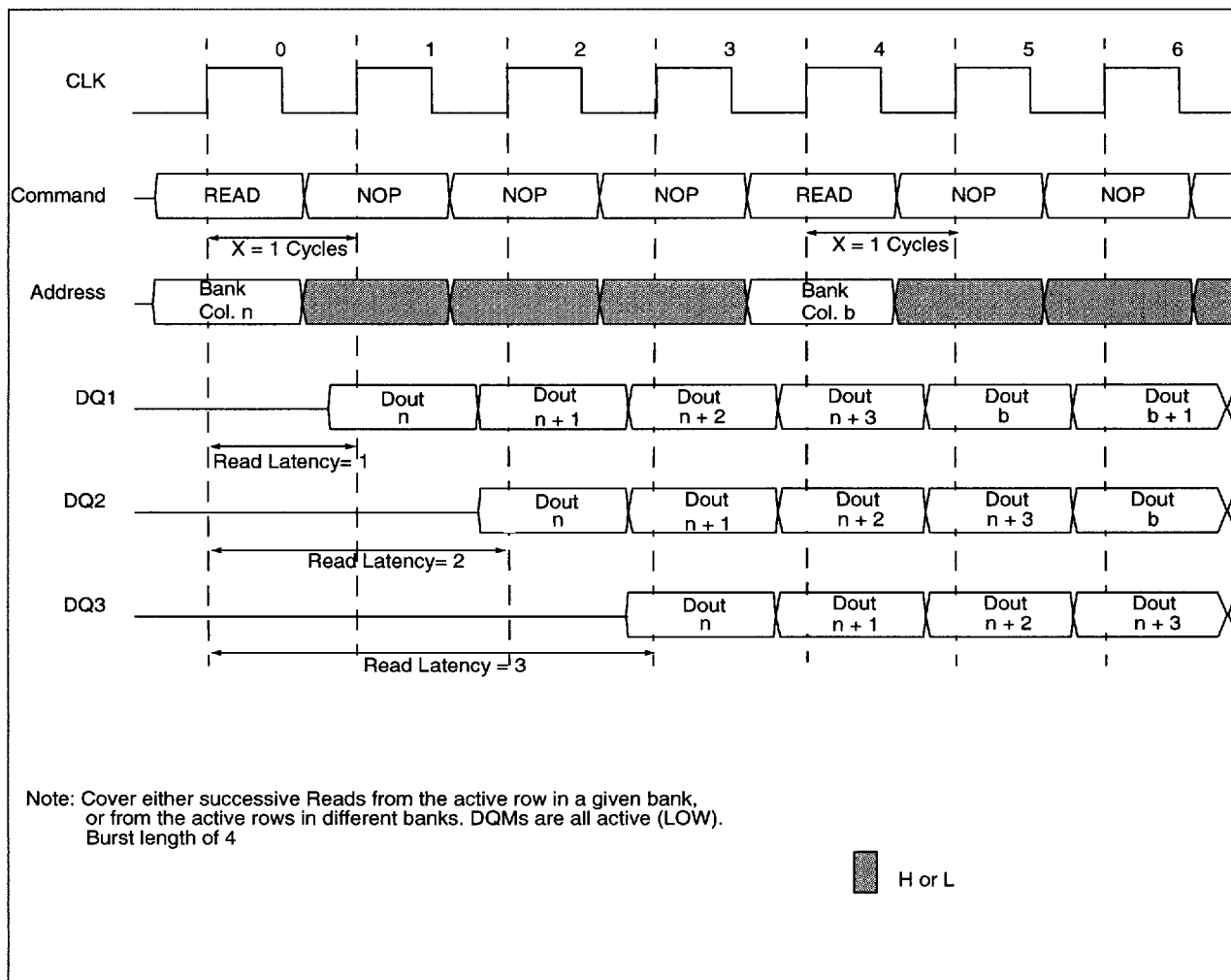
Read Burst with Read Latency = 2



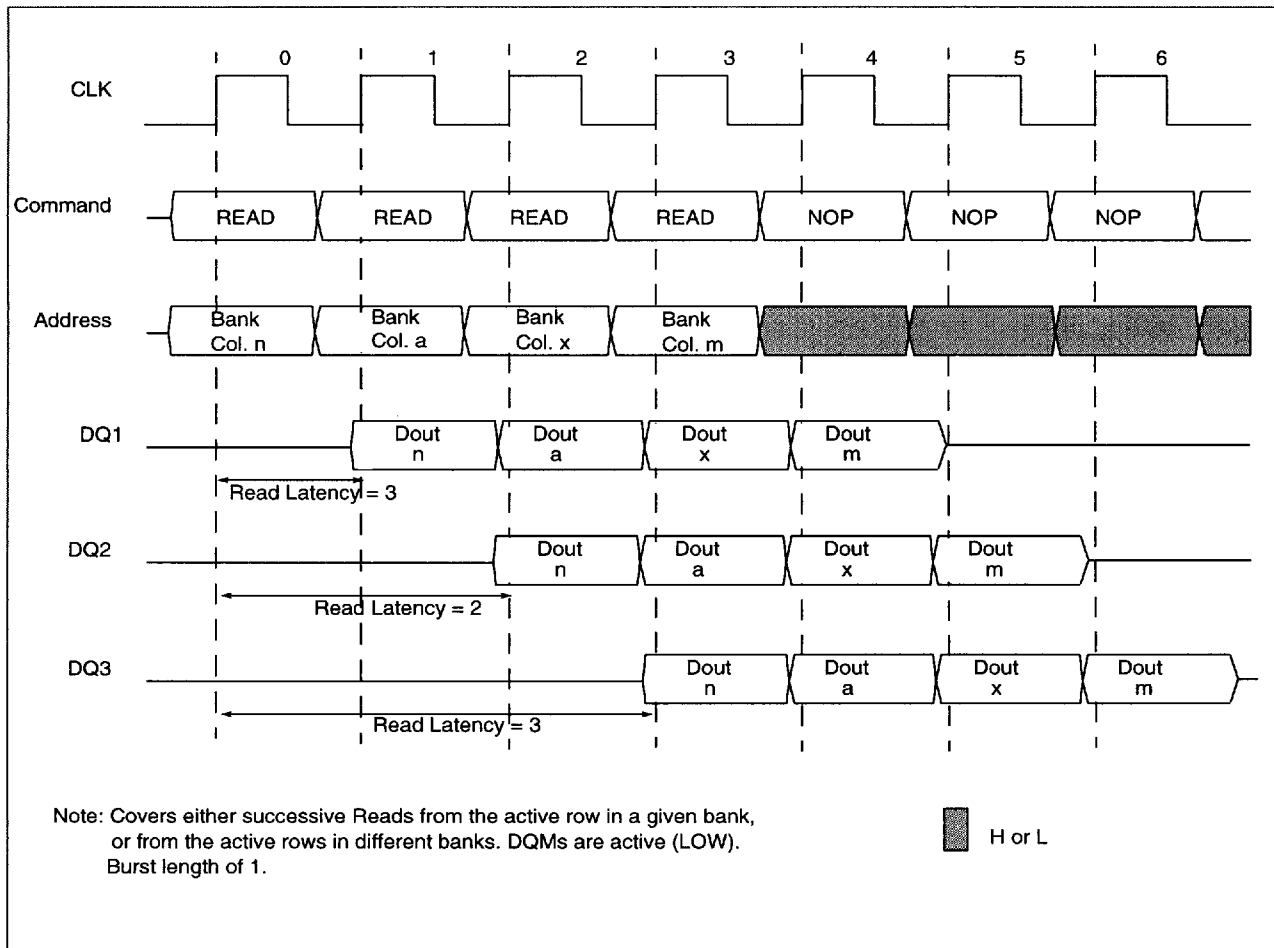
Read Burst with Read Latency = 3



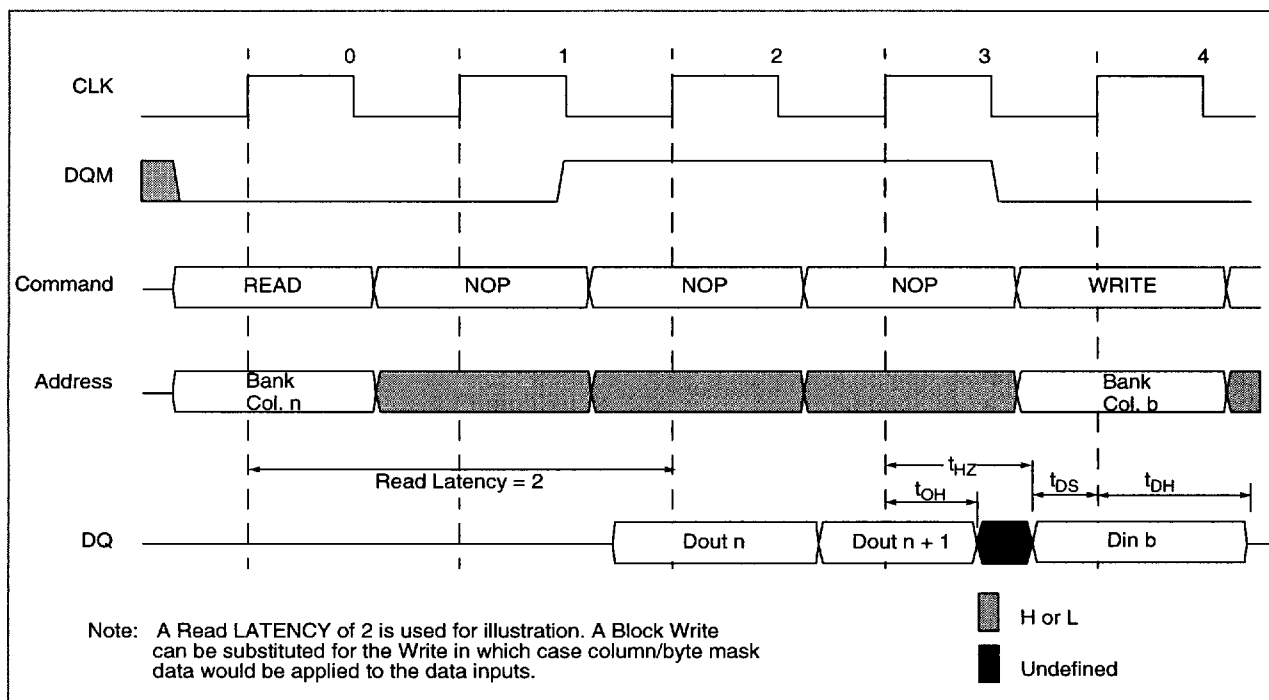
Consecutive Read Bursts, Read Latency = 1, 2, 3



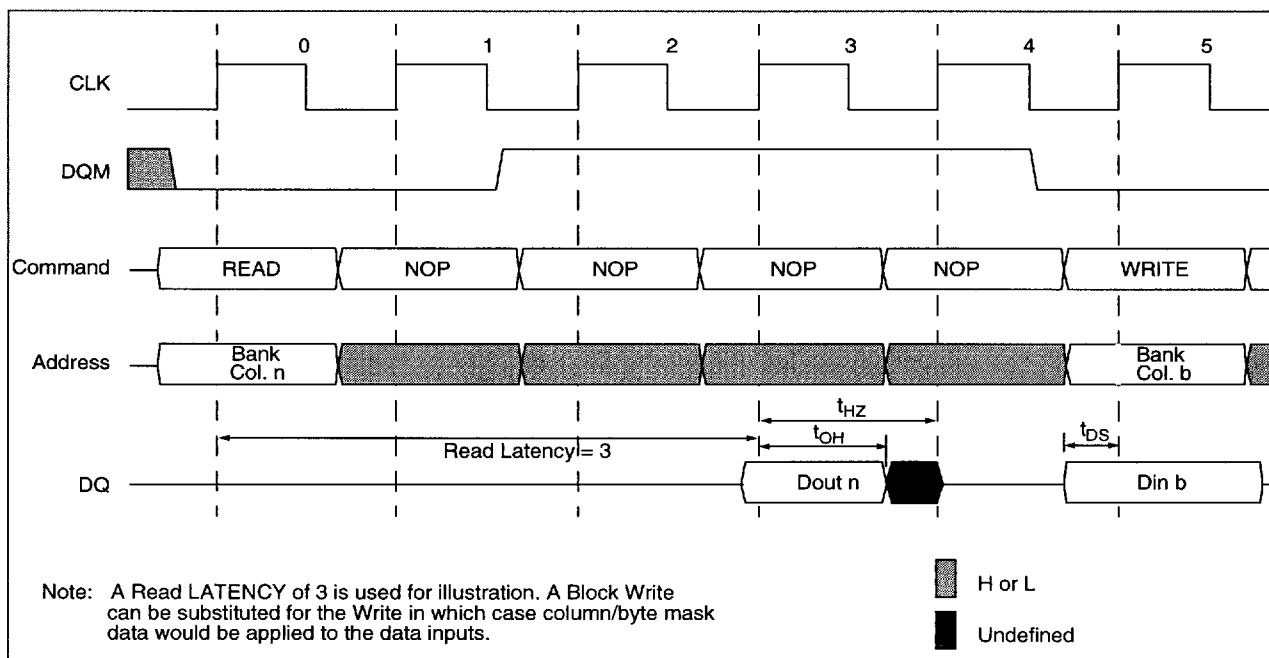
Random Read Accesses within a Page, Read Latency = 1, 2, 3



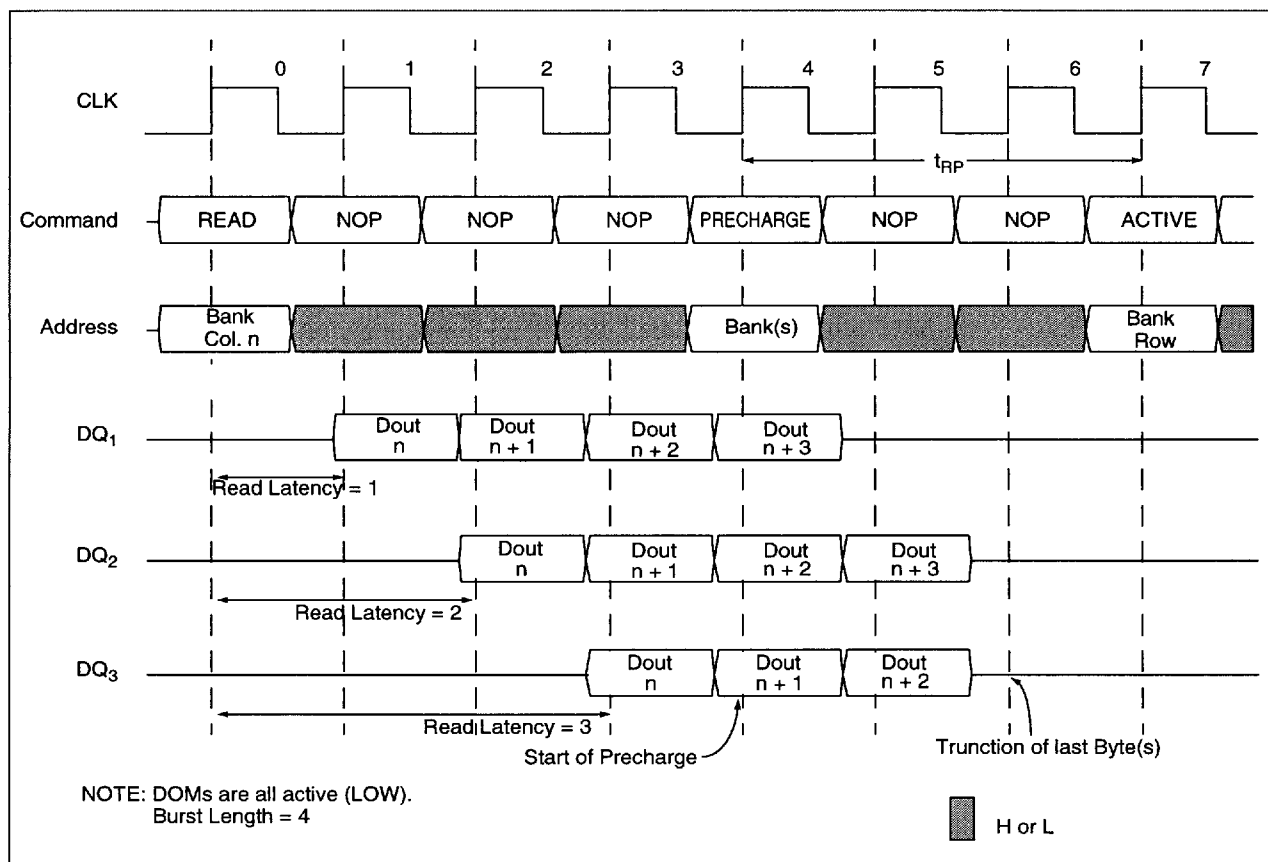
Read to Write (or Block Write)



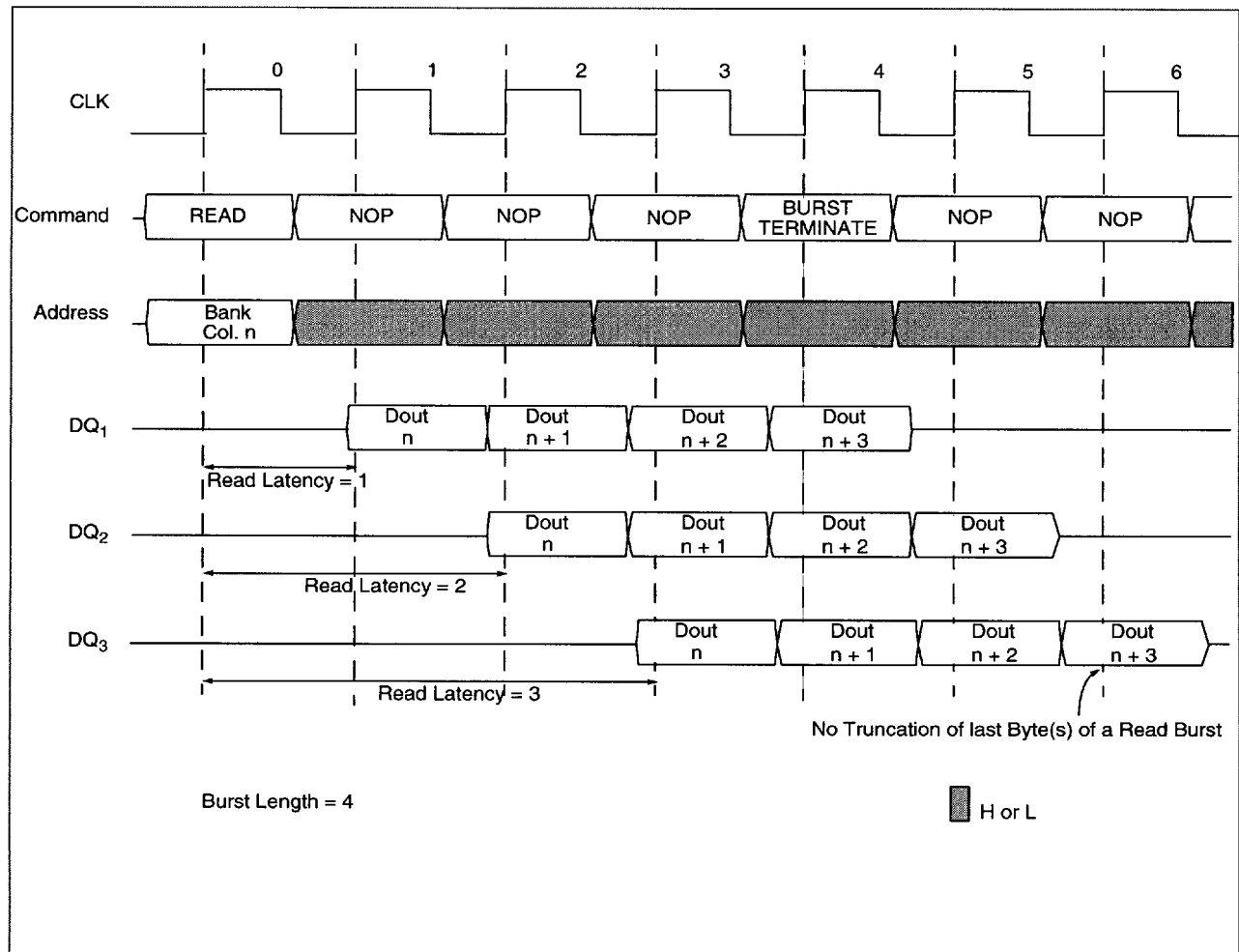
Read to Write with Extra Clock Cycle in between to avoid Contention



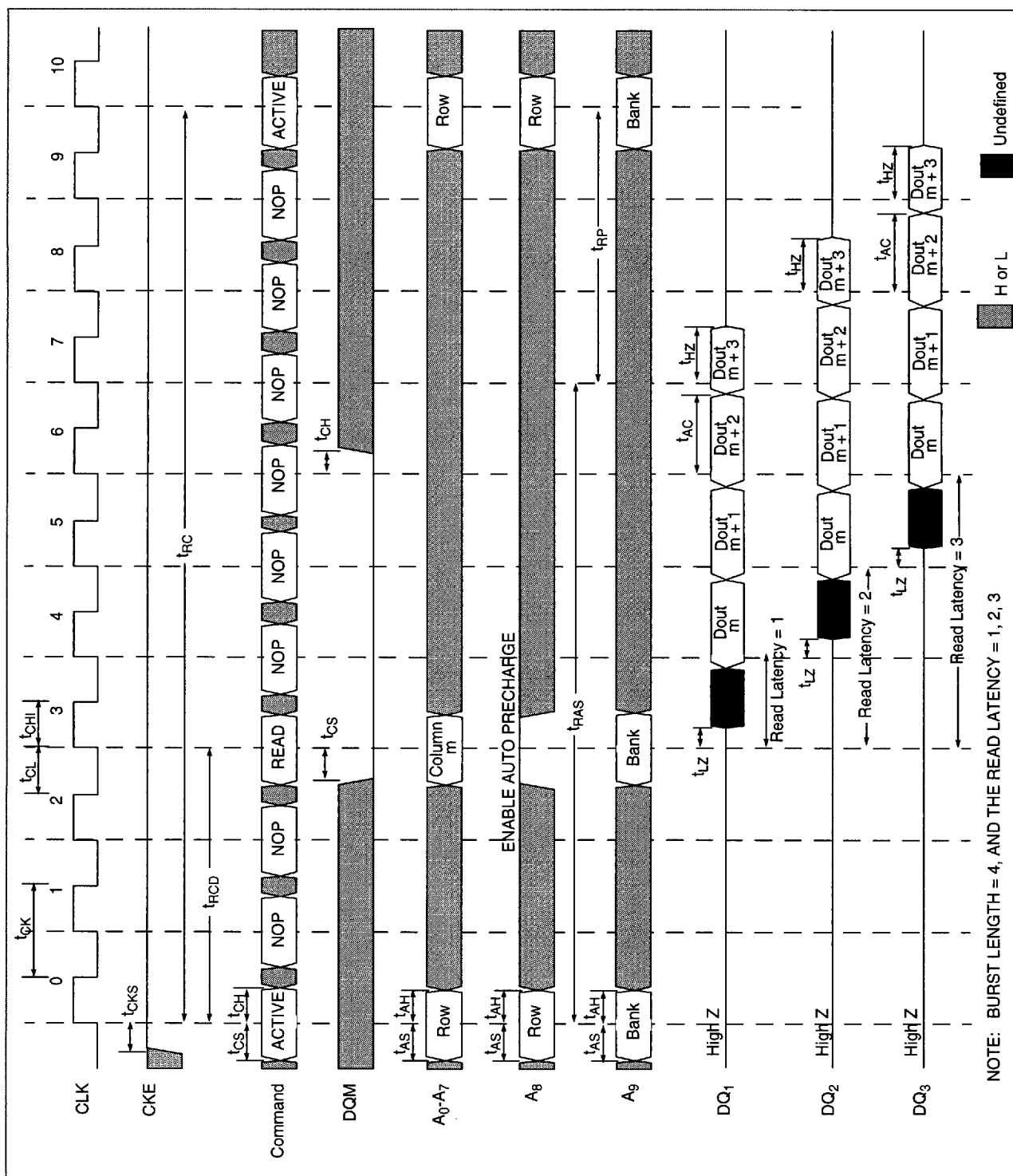
Read Interruption by Precharge Command, Read Latency = 1, 2, 3



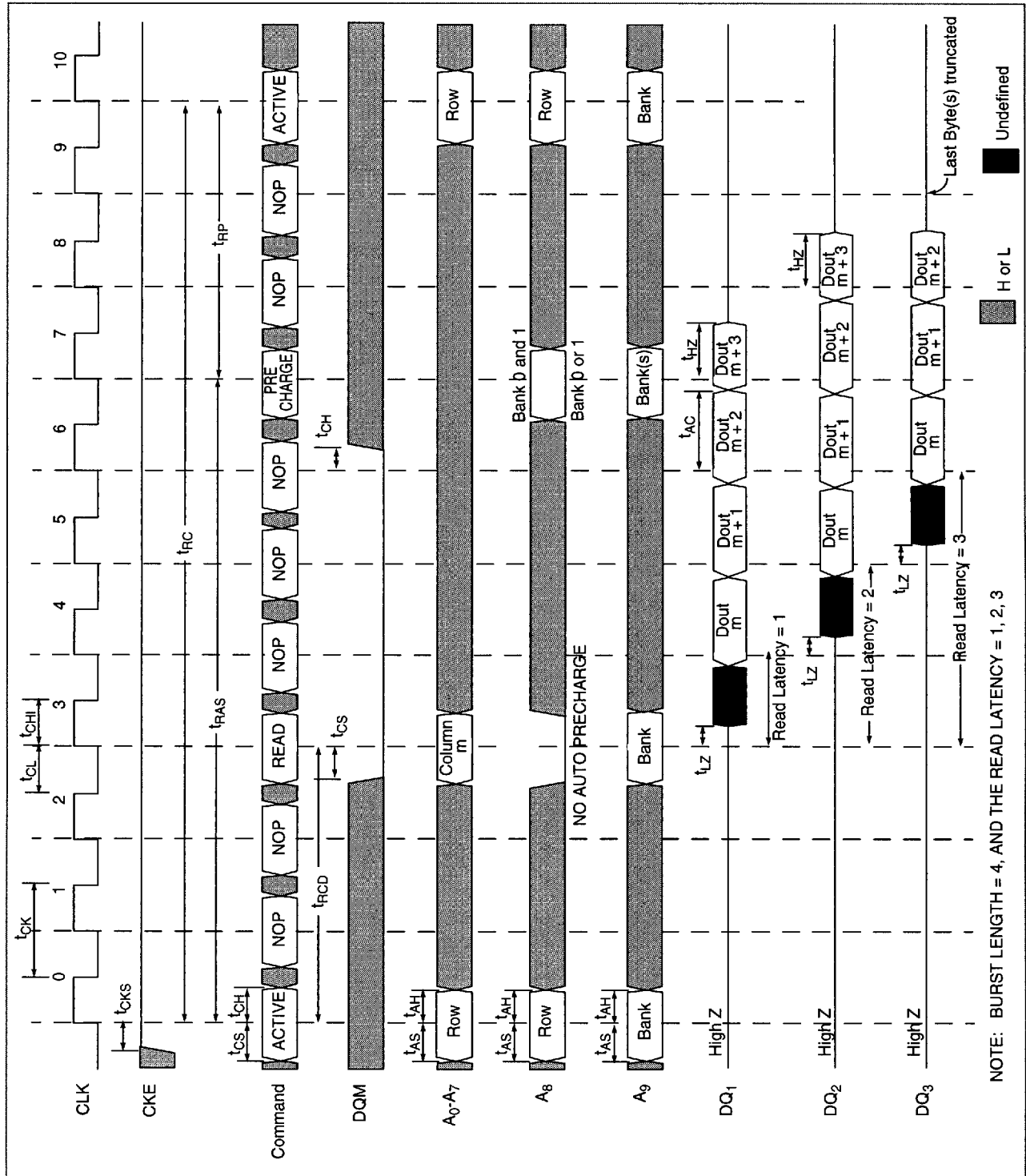
Terminating a Read Burst with a Burst Terminate command, Read Latency = 1, 2, 3



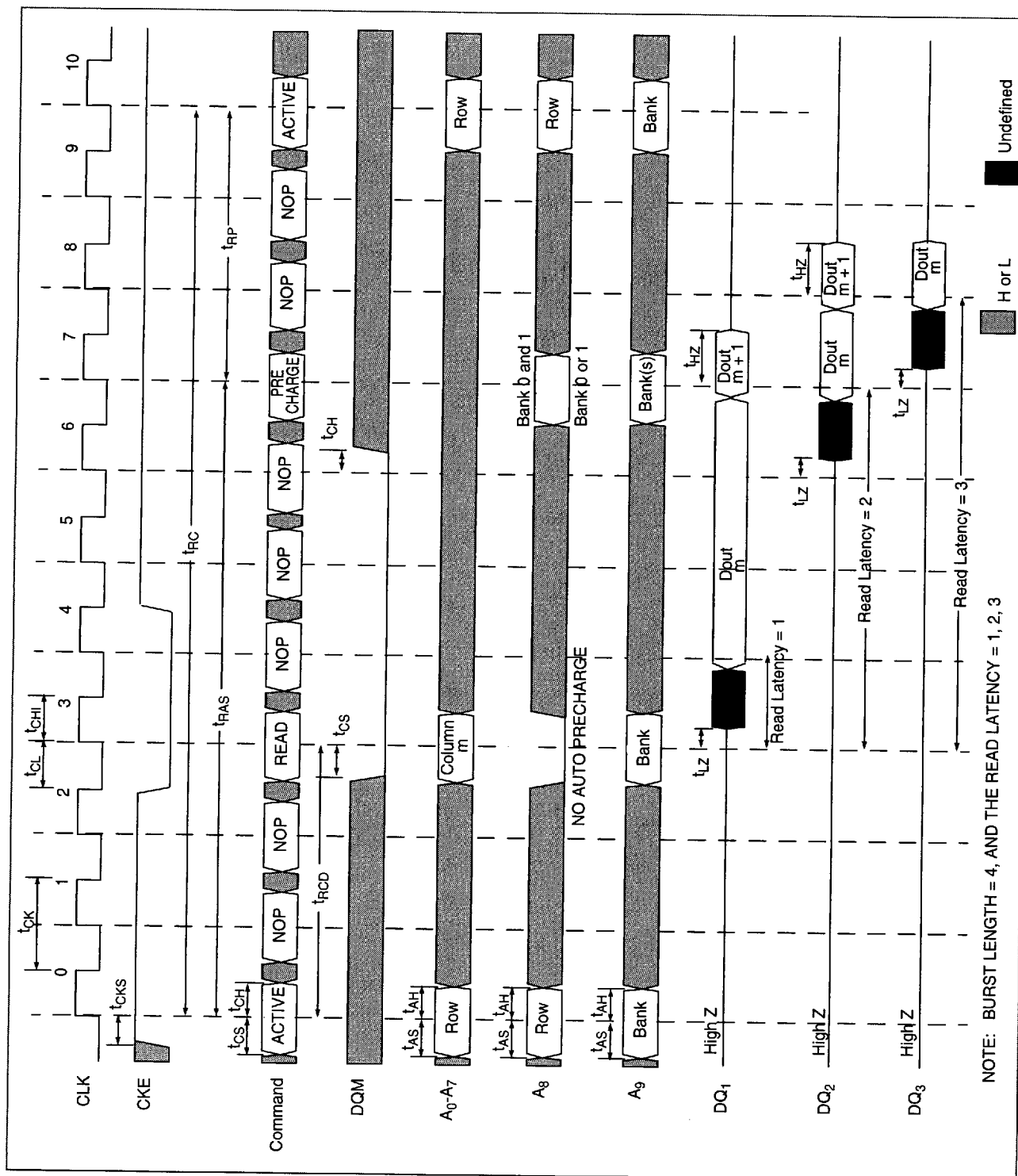
Read with Auto Precharge



Read without Auto Precharge

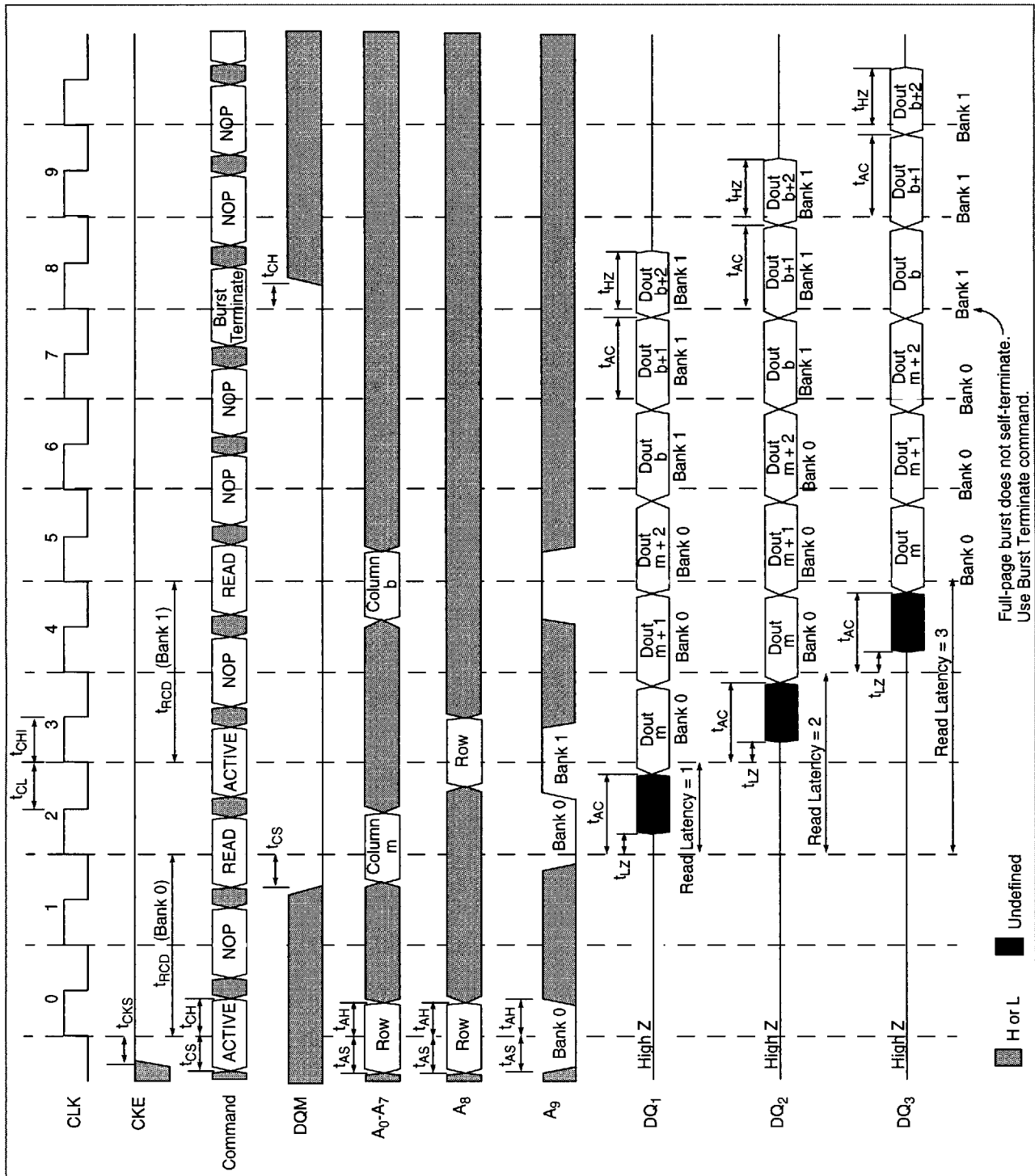


Read without Auto Precharge - Clock Suspension

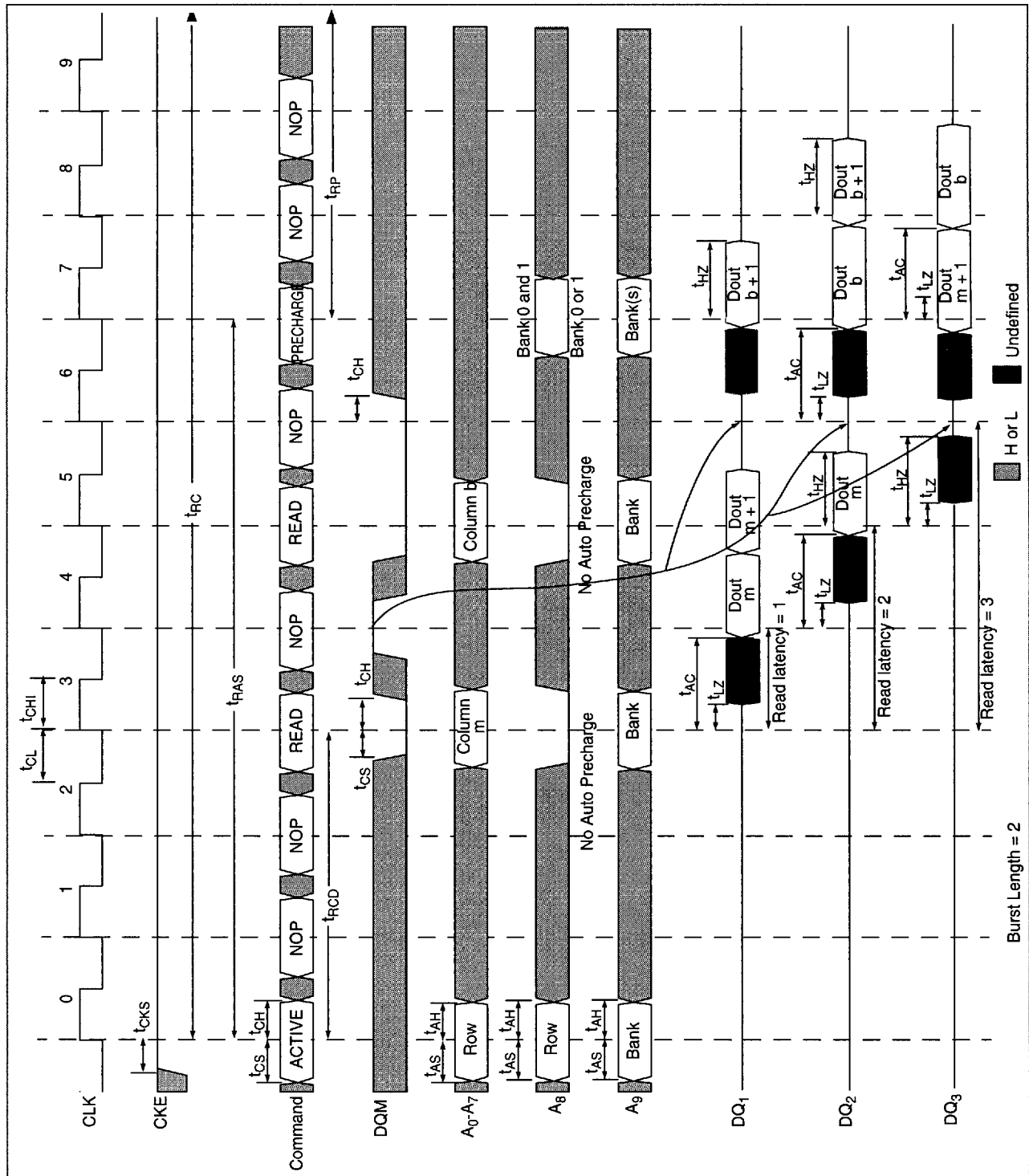




Read Full Page Burst (Interleaving two banks)



Read DQM Operation



Write Command (WR)

The following pages illustrate the Write operations for various cases with the help of timing diagrams.

Logic Table for Write Command

| Mnemonic | CKE | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A ₉ | A ₈ | A ₇ -A ₀ |
|----------|-----|-----------------|------------------|------------------|-----------------|-----|-----|----------------|----------------|--------------------------------|
| WR | H | L | H | L | L | L | 0 | BS | L | Column |
| WRA | H | L | H | L | L | L | 0 | BS | H | Column |
| BW | H | L | H | L | L | H | 0 | BS | L | Column |
| BWA | H | L | H | L | L | H | 0 | BS | H | Column |

Note: Input data at DQ pins at Block Write command time is registered as a column mask for that block of columns.

Write bursts are initiated with a Write command. The starting column and bank address is provided with the Write command, normal or Block Write is selected, and Auto Precharge is either enabled or disabled for that access. If Auto Precharge is enabled, the row being accessed is precharged automatically at the completion of the burst.

During Write bursts, the first valid data-in element will be registered coincident with the Write command. Subsequent data elements will be registered on successive positive clock edge. Upon completion of a fixed-length burst, assuming no other commands have been initiated, the DQs will remain High-Z, and any additional data will be ignored. A full-page burst will continue until terminated (at the end of the page, it will wrap to column 0 and continue).

A fixed-length Write burst may be followed by, or truncated with a subsequent Write burst or Block Write command (provided that Auto Precharge was not activated) and a full page Write burst can be truncated with a subsequent Write burst or Block Write command. The new Write or Block Write command can be issued on any clock following the previous Write command, and the data provided coincident with the new command applies to the new command.

A fixed-length Write burst may be followed by, or truncated with a subsequent Read burst (provided that Auto Precharge was not activated) and a full-page Write burst can be truncated with a subsequent Read burst. Once the Read command is registered, the data inputs will be ignored, and writes will not be executed.

A fixed-length Write burst may be followed by, or truncated with a Precharge command to the same bank (provided that Auto Precharge was not activated) and a full-page Write burst may be truncated with a Precharge command to the same bank. **The Precharge command should be issued x cycles ($x = t_{WR}/t_{CK}$ rounded up to the next whole number) after the clock edge at which the last desired input data element is registered.** In addition, the DQM signals must be used to mask input data, starting with the clock edge following the last desired data element and ending with the clock edge on which the Precharge command is entered. A Precharge command issued at the optimum time provides the same operation that would result from the same fixed-length Burst with Auto Precharge.

Disadvantages of Write command with Auto Precharge

1. Back to back Read/Write bursts can not be initiated. The Read/Write command with Auto Precharge will automatically initiate a precharge of the row in the selected bank. Most of the applications require subsequent Read/Write bursts in the same page.
2. The Auto Precharge command does not allow truncation of fixed-length bursts. It also does not apply to Full Page bursts.

Terminating a Write burst

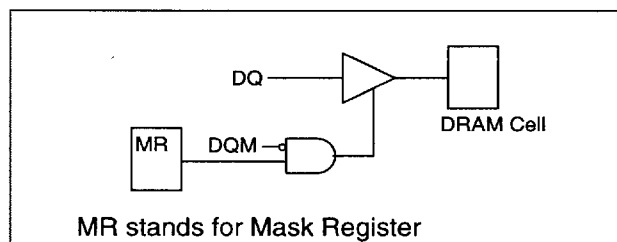
The fixed-length or Full-Page Write bursts can be truncated with the Burst Terminate command. When truncating a Write burst, the input data applied one clock edge prior to the Burst Terminate command will be the last data written.

Masked Writes

Any Write performed to a row that was activated via an Active with WPB command is a Write-per-Bit-Mask (WPBM). Data is written to the 32 cells at the selected column location subject to the mask stored in the WPB mask register. The data to be written in the DRAM cell will be according to the following logic.

| DQM | MR | DRAM Cell |
|-----|----|-----------|
| 0 | 0 | Mask |
| 1 | 0 | Mask |
| 1 | 1 | Mask |
| 0 | 1 | Write |

Write Masking Functional Representation



If a particular bit in the WPB mask register is a "0", the data appearing on the corresponding DQ input will be ignored, and the existing data in the corresponding DRAM cell will remain unchanged. If a mask data is a "1", the data appearing on the corresponding DQ input will be written to the corresponding DRAM cell. **The overall Write mask consists of a combination of the DQM inputs, which will mask on a per-byte basis, and the WPB mask register, which masks on a per-bit basis.** If a particular DQM signal was registered high, the corresponding byte will be masked. A given bit is written if the corresponding DQM signal registered is "0" and the corresponding WPB mask register bit is "1". Note that the DQM Latency for Write is zero.

Block Write (BW)

Each Block Write cycle writes a single data value from the color register to the block of eight consecutive column locations addressed by A_7 - A_3 . The information on the DQs which is registered coincident with the Block Write command is used to mask specific column/byte combinations within the block. The masking of various DQ planes /column is according to the following functional logic.

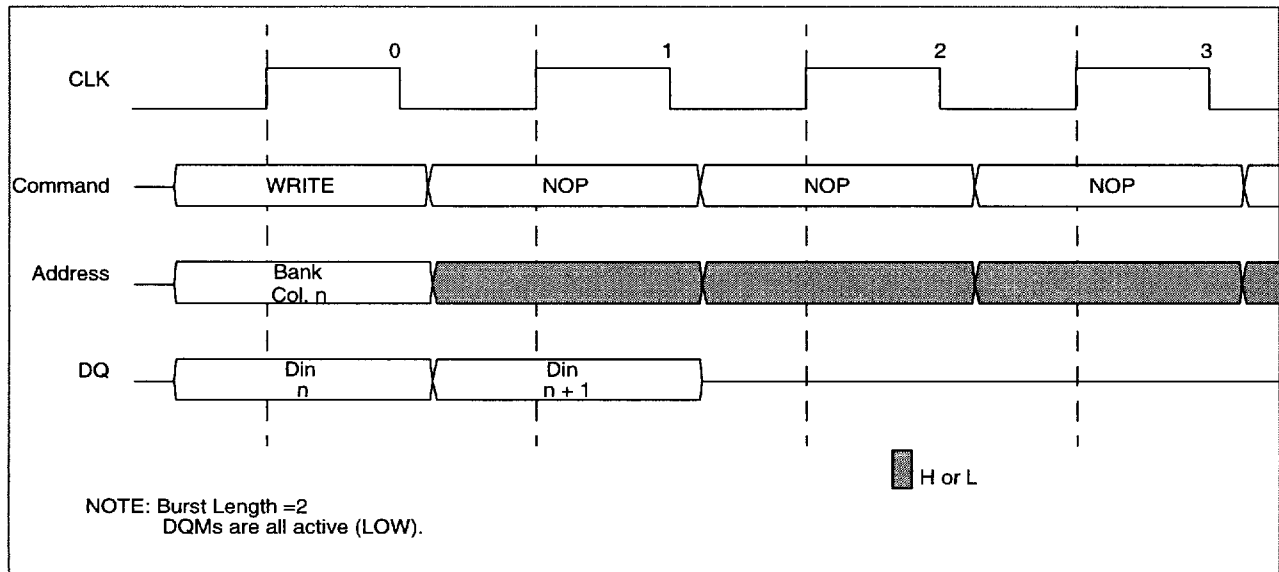
| DQs | Column Address | | | DQ Planes Affected |
|-------------------------------------|----------------|-------|-------|-----------------------------------|
| | A_2 | A_1 | A_0 | |
| DQ ₀ - DQ ₇ | X | Y | Z | P ₀ - P ₇ |
| DQ ₈ - DQ ₁₅ | X | Y | Z | P ₈ - P ₁₅ |
| DQ ₁₆ - DQ ₂₃ | X | Y | Z | P ₁₆ - P ₂₃ |
| DQ ₂₄ - DQ ₃₁ | X | Y | Z | P ₂₄ - P ₃₁ |

For example, if DQ₀ is "0", then {X,Y,Z} becomes {0,0,0} and the column 0 with its planes 0-7 is masked from the selected block of columns. If DQ₁₄ is "0", then {X,Y,Z} becomes {1,1,0} and the column with address 6 with its planes 8-15 is masked from the selected block of columns. When a "0" is registered in a particular DQ signal coincident with a Block Write command, the write to the corresponding column/byte combination is masked. When a "1" is registered, the Color Register data will be written to the corresponding DRAM cells, subject to the DQM and the WPB masking. The overall Block Write mask consists of a combination of the DQM signals, the WPB mask register and the column/byte mask information.

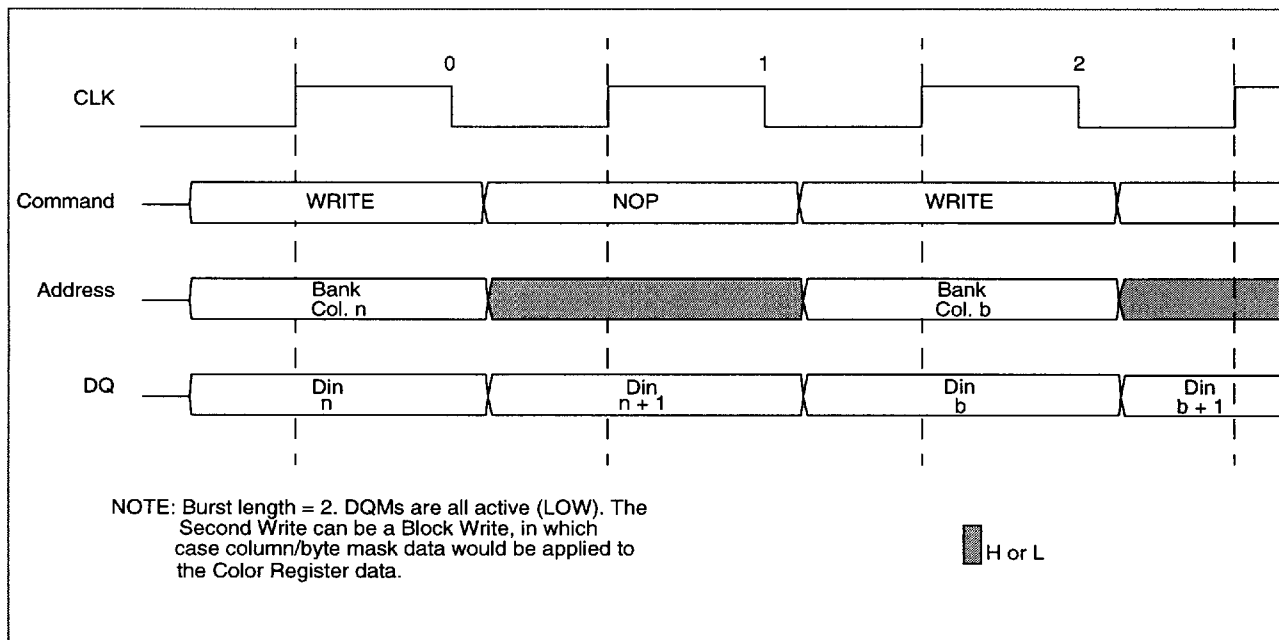
Block Write Timing Considerations.

A Block Write access requires a time period of t_{BWC} to execute, so in general, the cycle after the Block Write command should be a NOP. However, Active or Precharge commands to the other bank are allowed. When following a Block Write with a Precharge command to the same bank, t_{BPL} must be met.

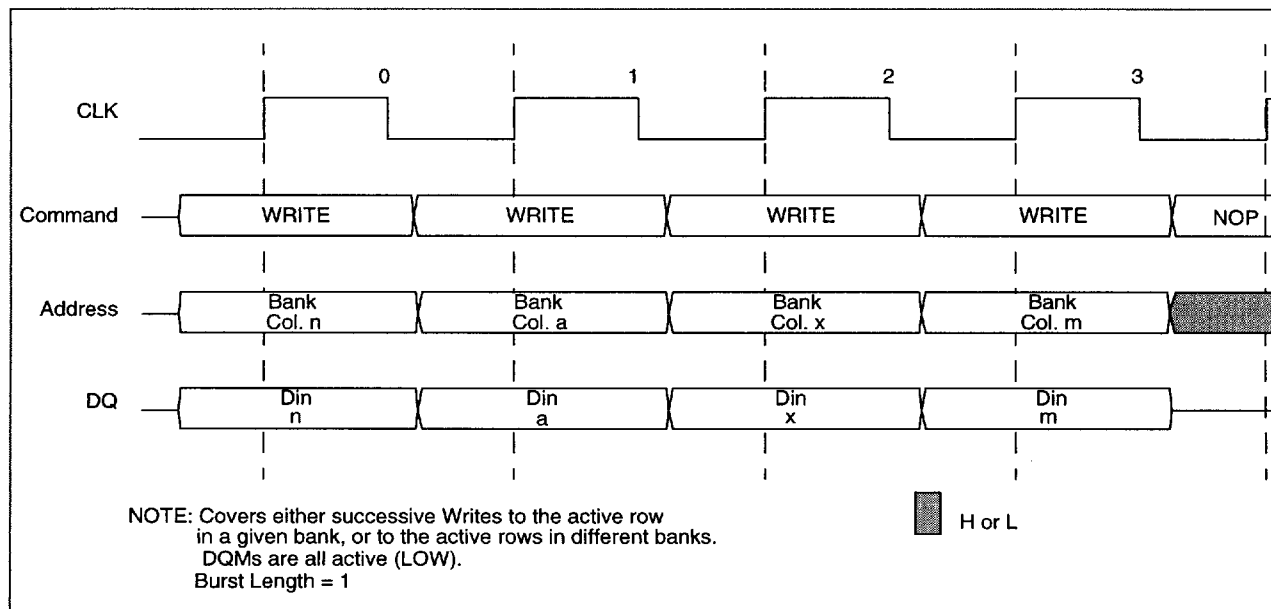
Write Burst



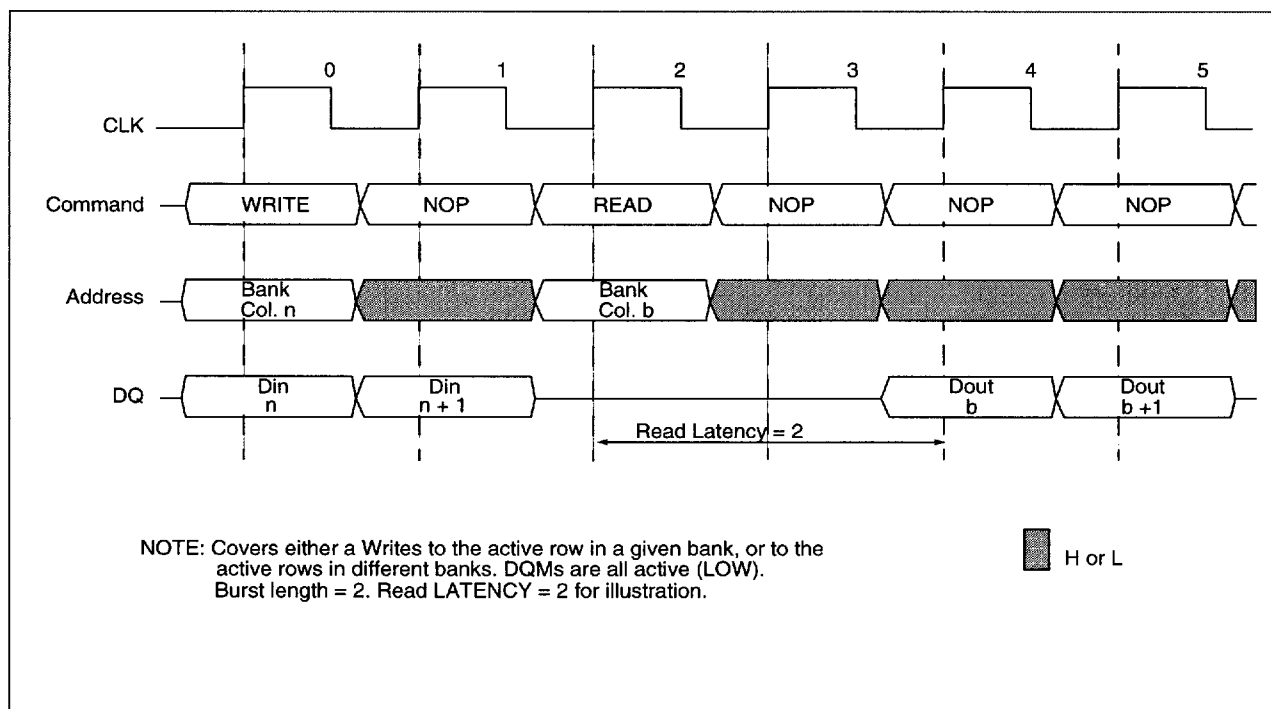
Write to Write (or Block Write)



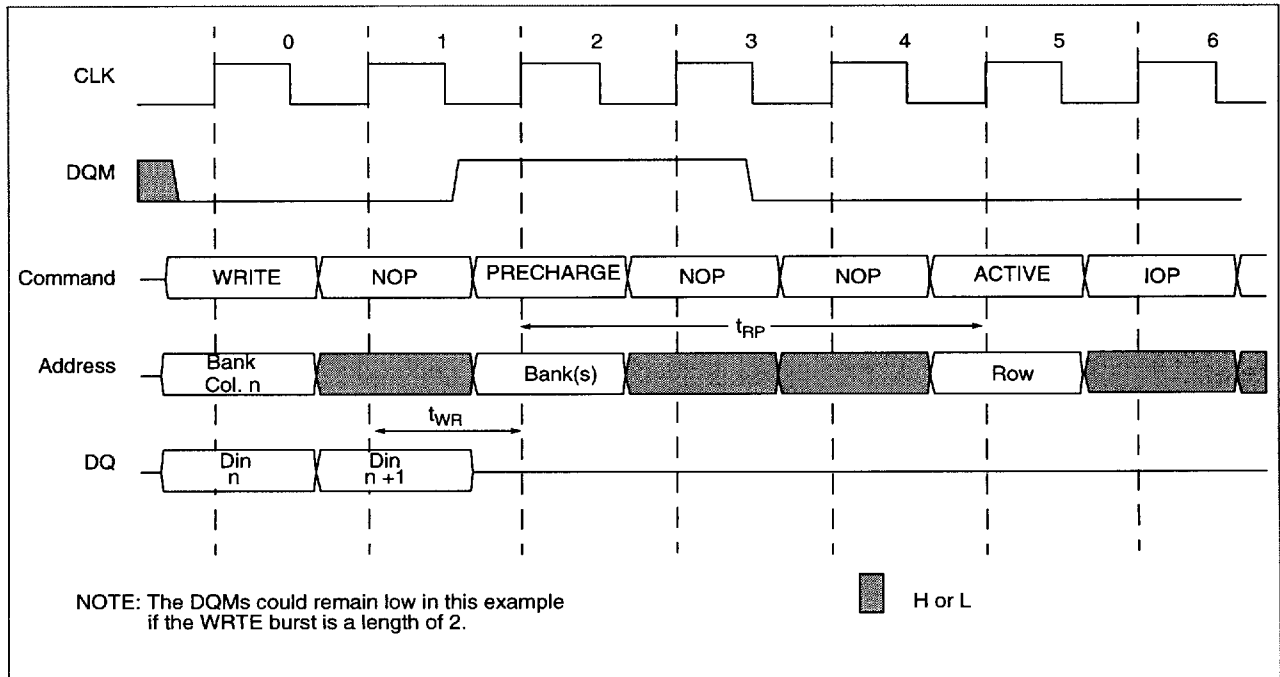
Random Write (or Block Write) Cycles within a Page



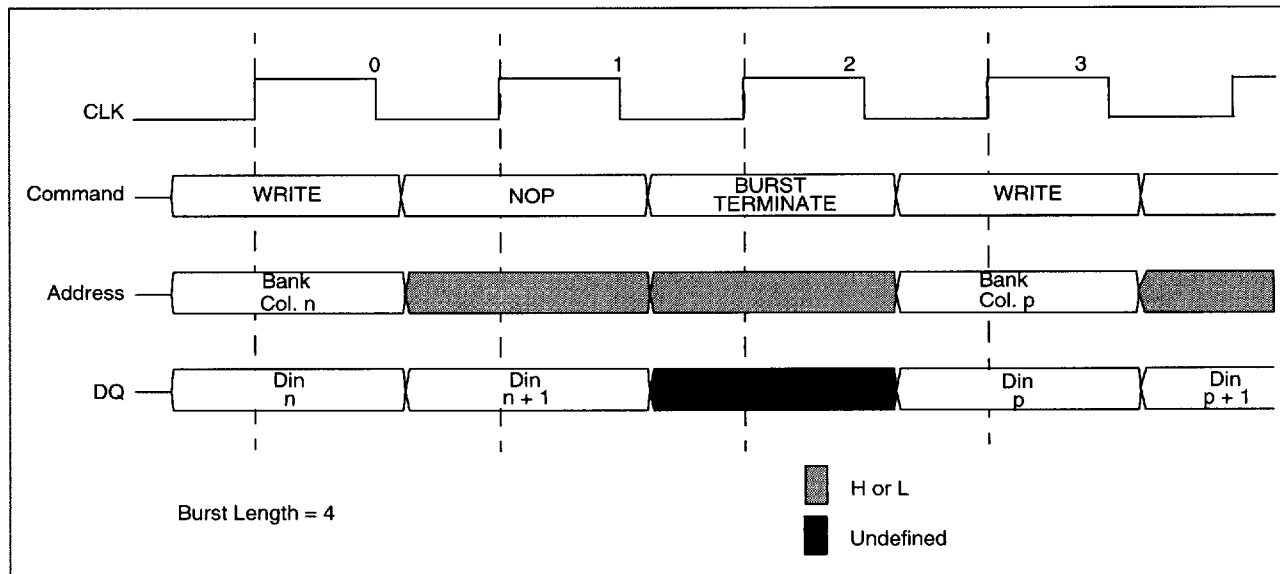
Write to Read



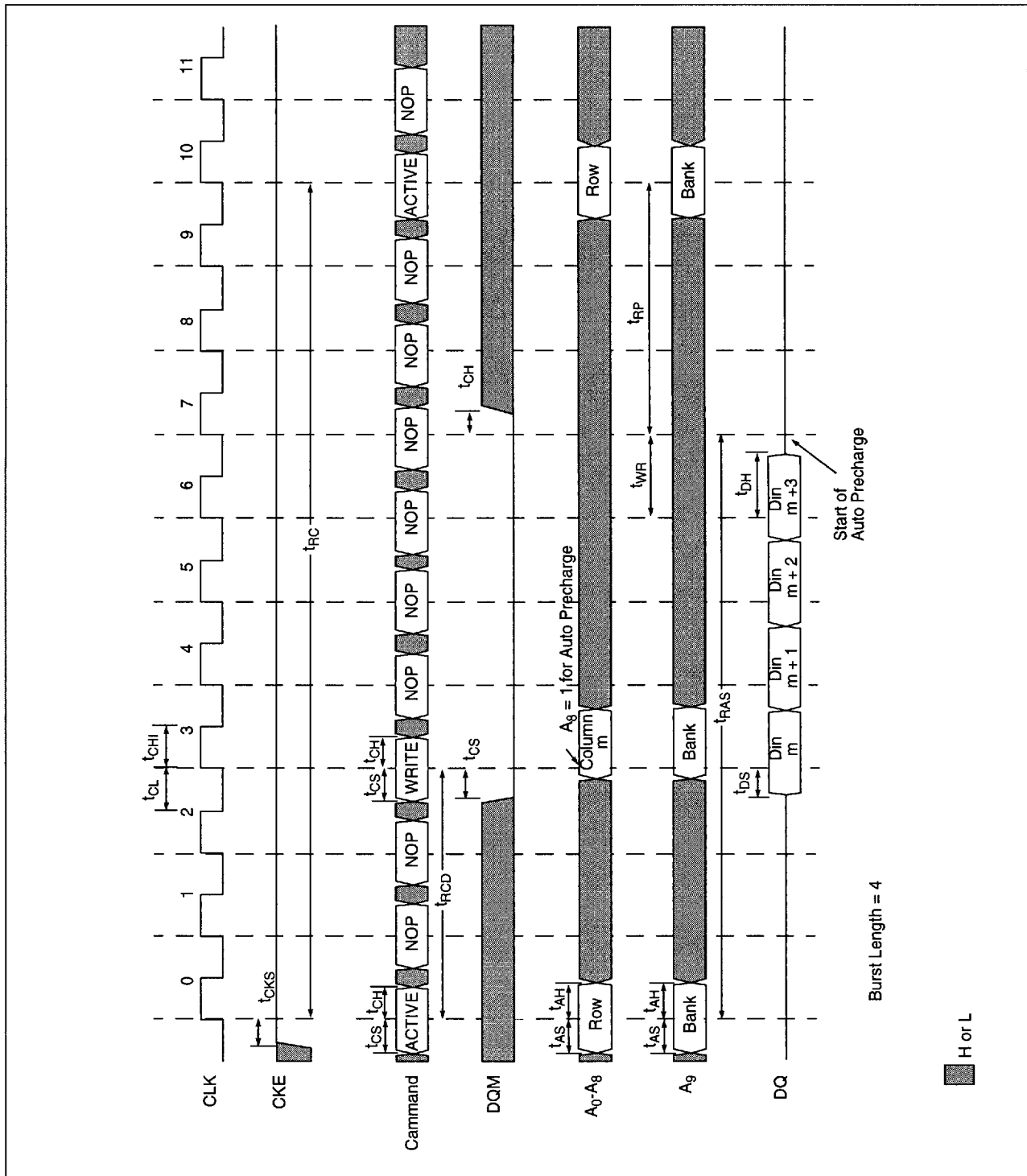
Write to Precharge



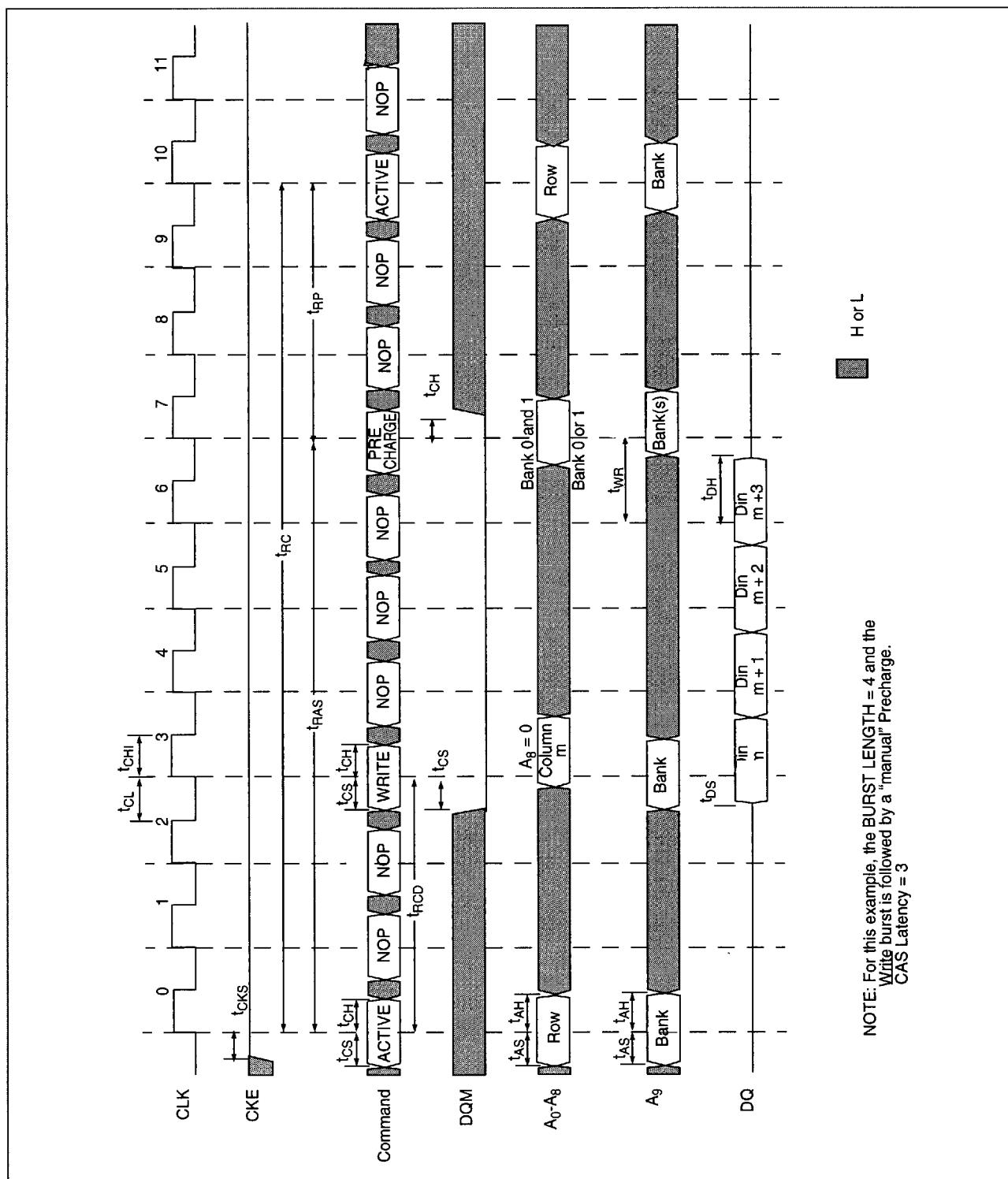
Terminating a Write Burst



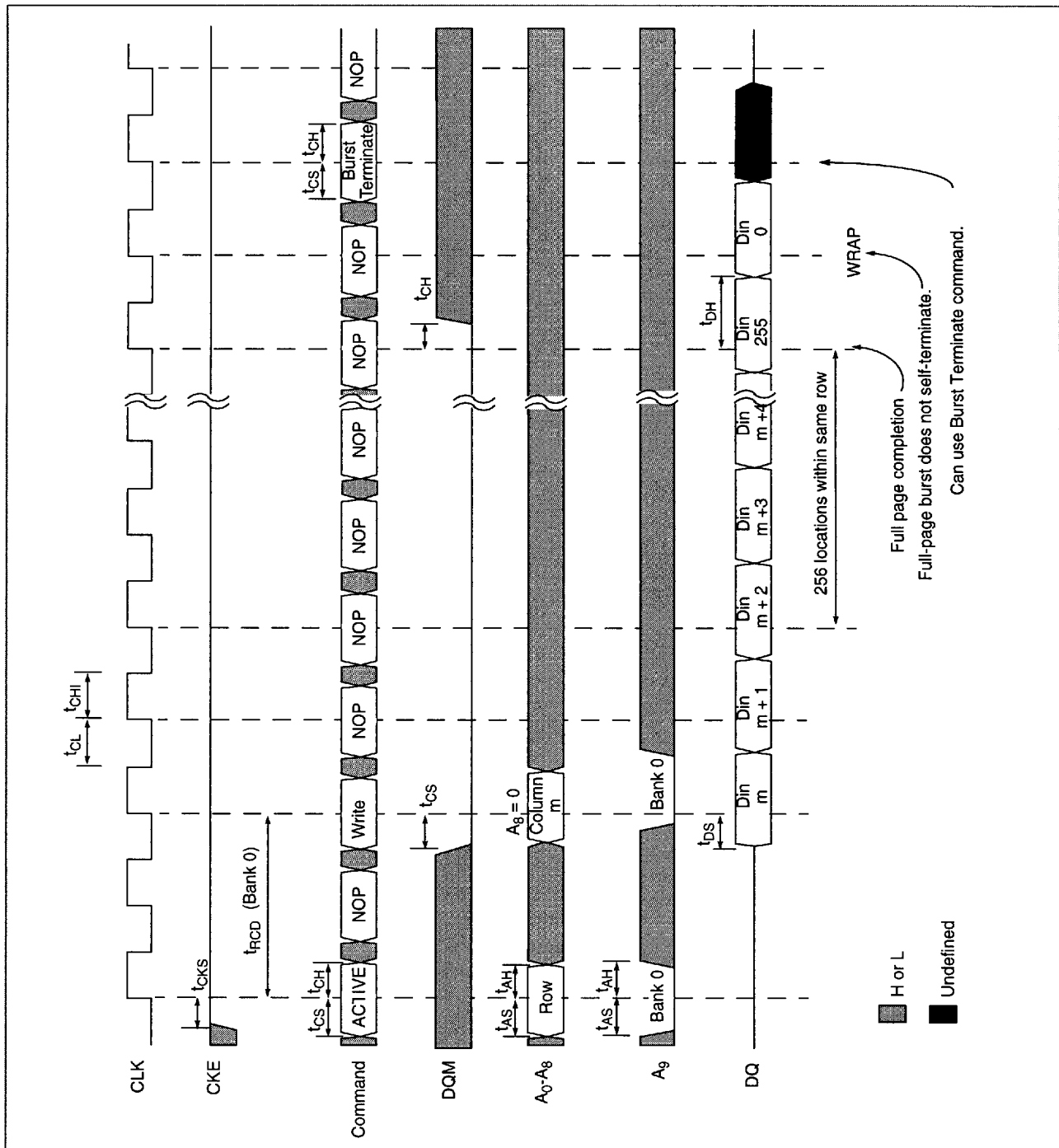
Write with Auto Precharge



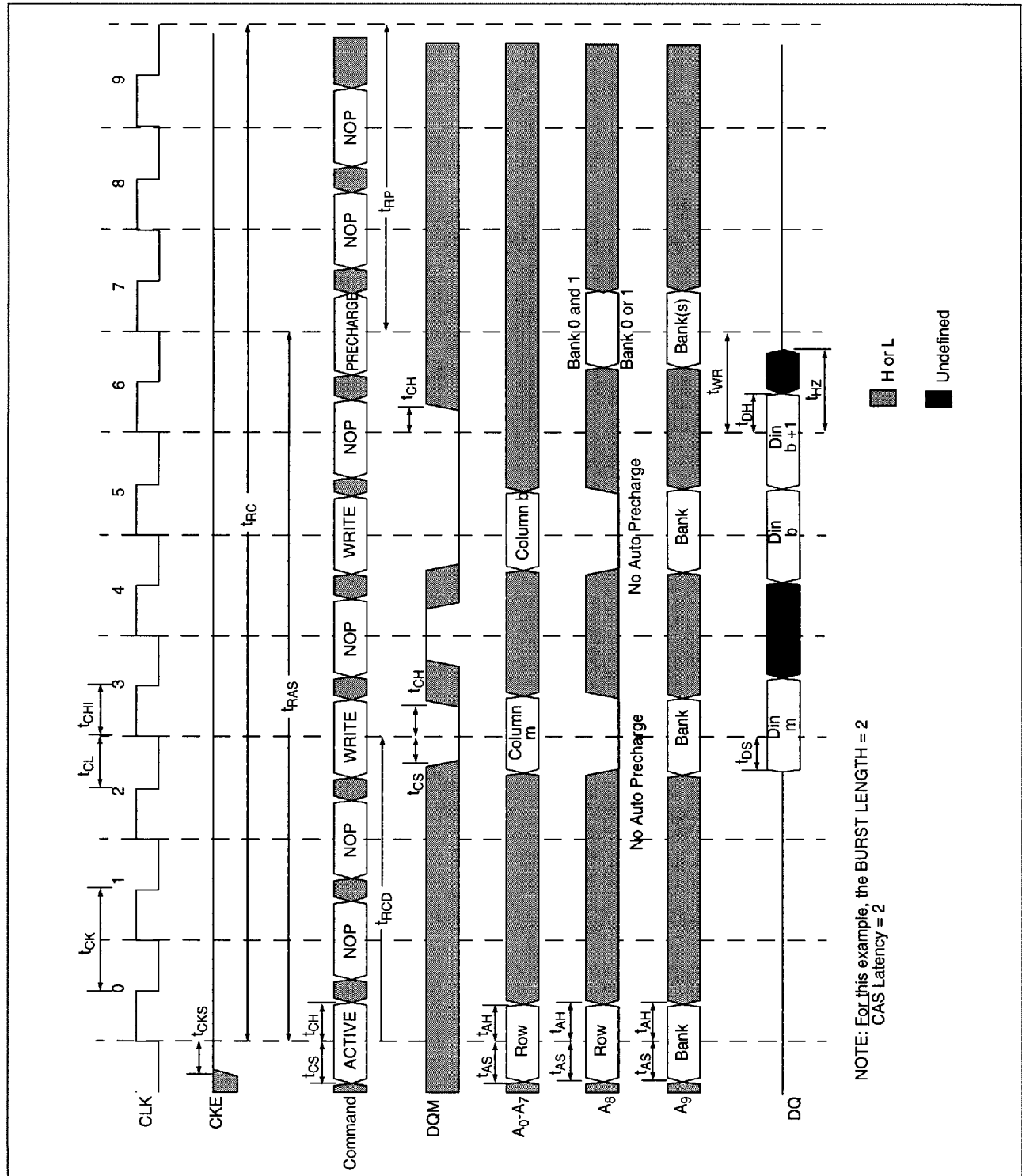
Write without Auto Precharge



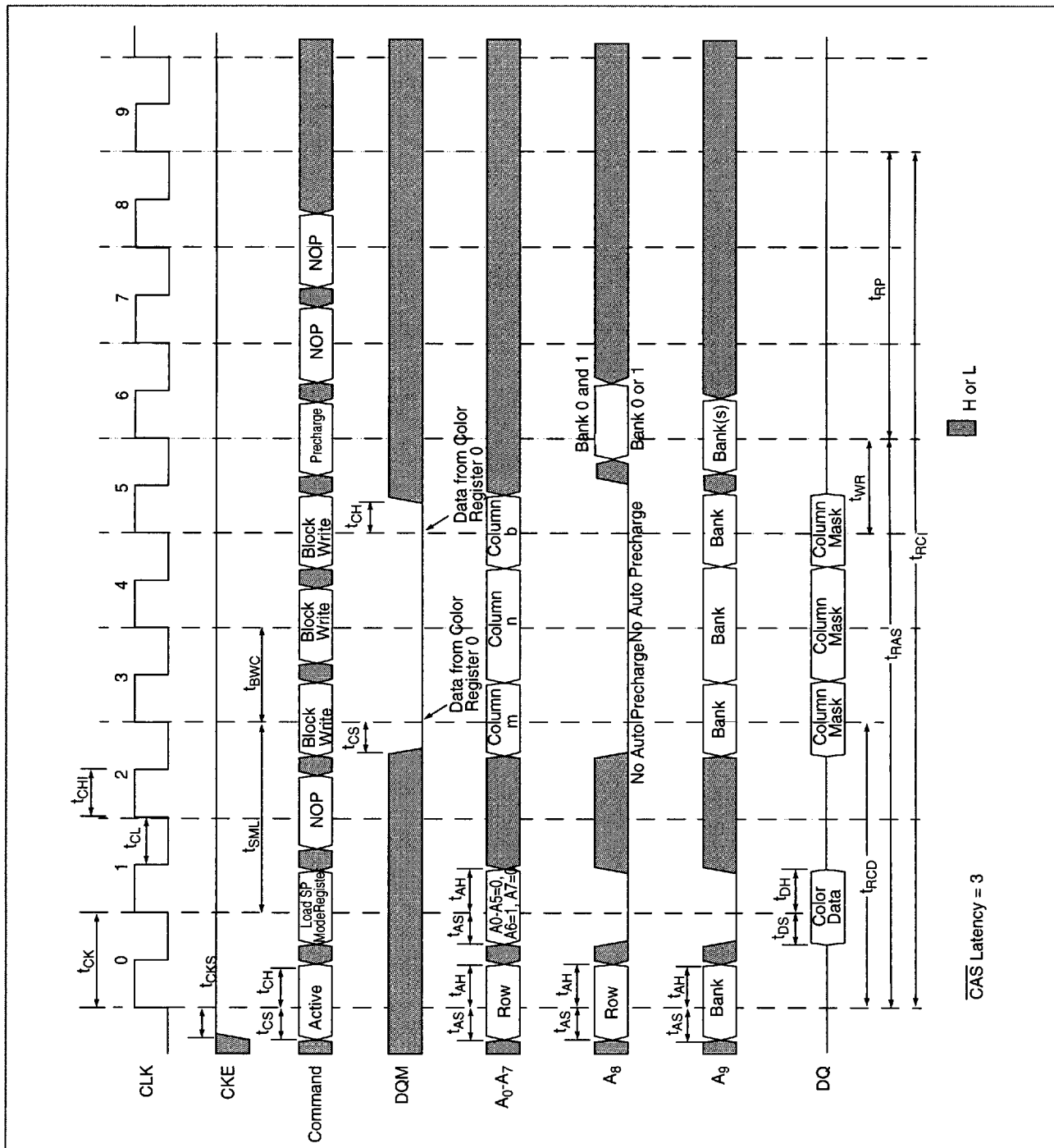
Write Full Page Burst



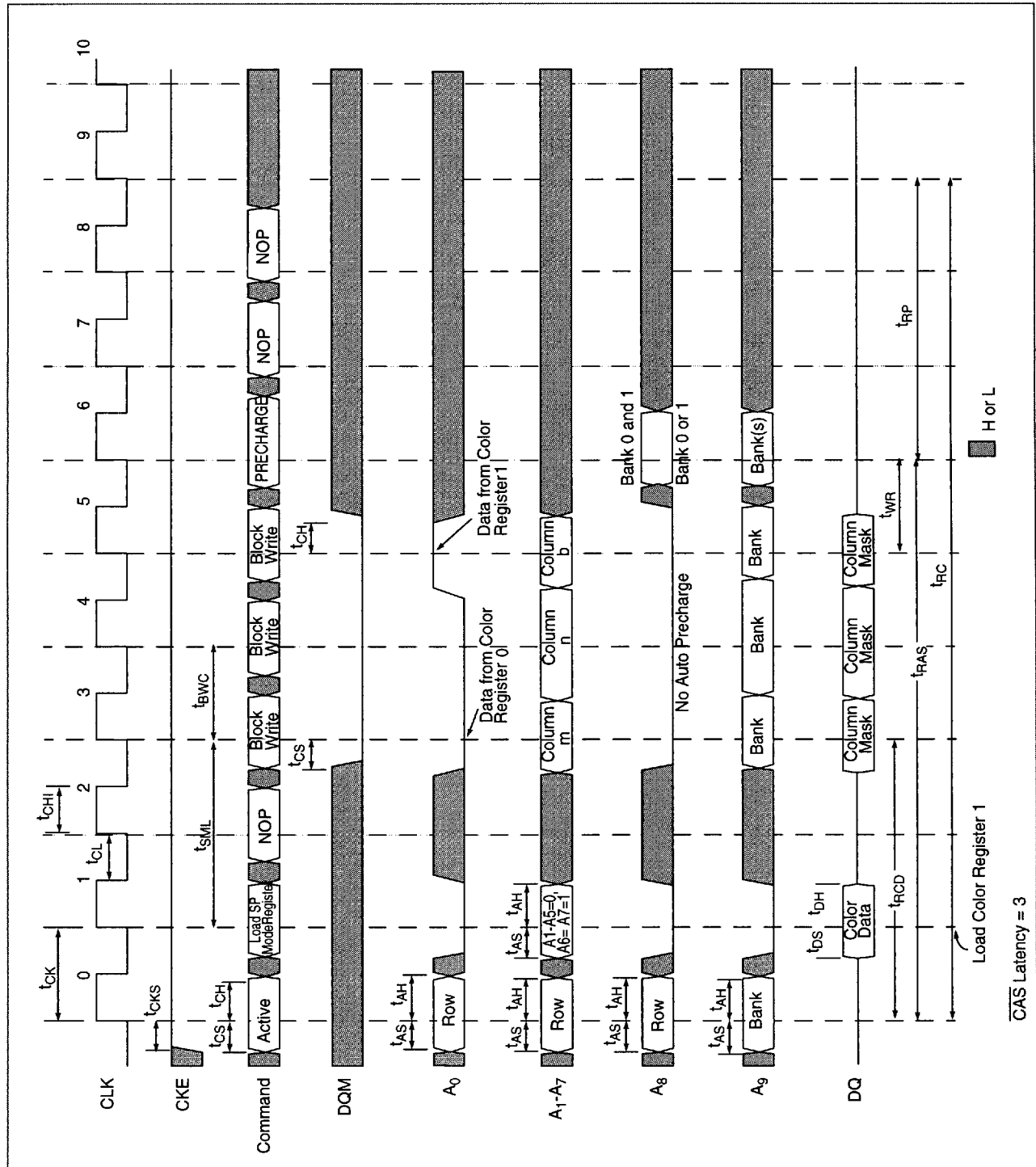
Write DQM Operation



Block Write (1 Color Register)



Block Write (Multiple Color Registers)



Precharge Command

The Precharge command is used to deactivate the open row in a particular bank, or the open row in both banks. Whenever, a user wants to activate or open another row in the same bank, he must initiate the Precharge command. This process causes a significant latency known as Row Latency.

Logic Table for Precharge Command

| Mnemonic | CKE | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A ₉ | A ₈ | A ₇ -A ₀ |
|----------|-----|-----------------|------------------|------------------|-----------------|-----|-----|----------------|----------------|--------------------------------|
| PRE | H | L | L | L | L | L | X | BS | L | X |
| PREALL | H | L | L | L | L | L | X | X | H | X |

The bank(s) will be available for a subsequent row access some specified time (t_{RP}) after the Precharge command is issued. Once a bank has been precharged, it is in idle state and must be activated prior to any Read, Write, or Block Write commands being issued to the same bank.

Power Down

Logic Table for Power Down

| Mnemonic | CKE | | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A ₉ | A ₈ | A ₇ -A ₀ |
|-----------|-----|---|-----------------|------------------|------------------|-----------------|-----|-----|----------------|----------------|--------------------------------|
| | n-1 | n | | | | | | | | | |
| PDN (ENT) | H | L | X | X | X | X | X | X | X | X | X |
| PDN (EXT) | L | H | X | X | X | X | X | X | X | X | X |

Power Down occurs when both banks are in idle state (precharged) and CKE is registered low. Entering Power Down deactivates the input and output buffers, excluding CKE for maximum power savings while in standby. In this mode the internal clock is suspended to save power. The device should be refreshed every 16ms to keep the DRAMs cells alive by initiating Auto Refresh command cycles. Note that in Power Down Mode no internal refresh operations are being performed..

The Power Down state is exited by taking CKE back high. CKE must go High, t_{CKS} before a positive clock edge, after meeting t_{CKH} from the previous clock edge. The first command after exiting Power Down will be registered on the clock edge following t_{CKS} . Exiting Power Down at clock edge n will put the device in the "all banks idle" state in time for clock edge n+1.

Self Refresh Mode (SREF)

The Self Refresh Mode is used to keep the device refreshed during its sleep mode for battery powered systems to conserve power.

SREF (ENT) command will put the device in Self Refresh mode and the information in the memory cells will be kept alive by refreshing the DRAM cells internally by initiating 1024 cycles every 64ms or 128ms or 256ms depending on the device used.

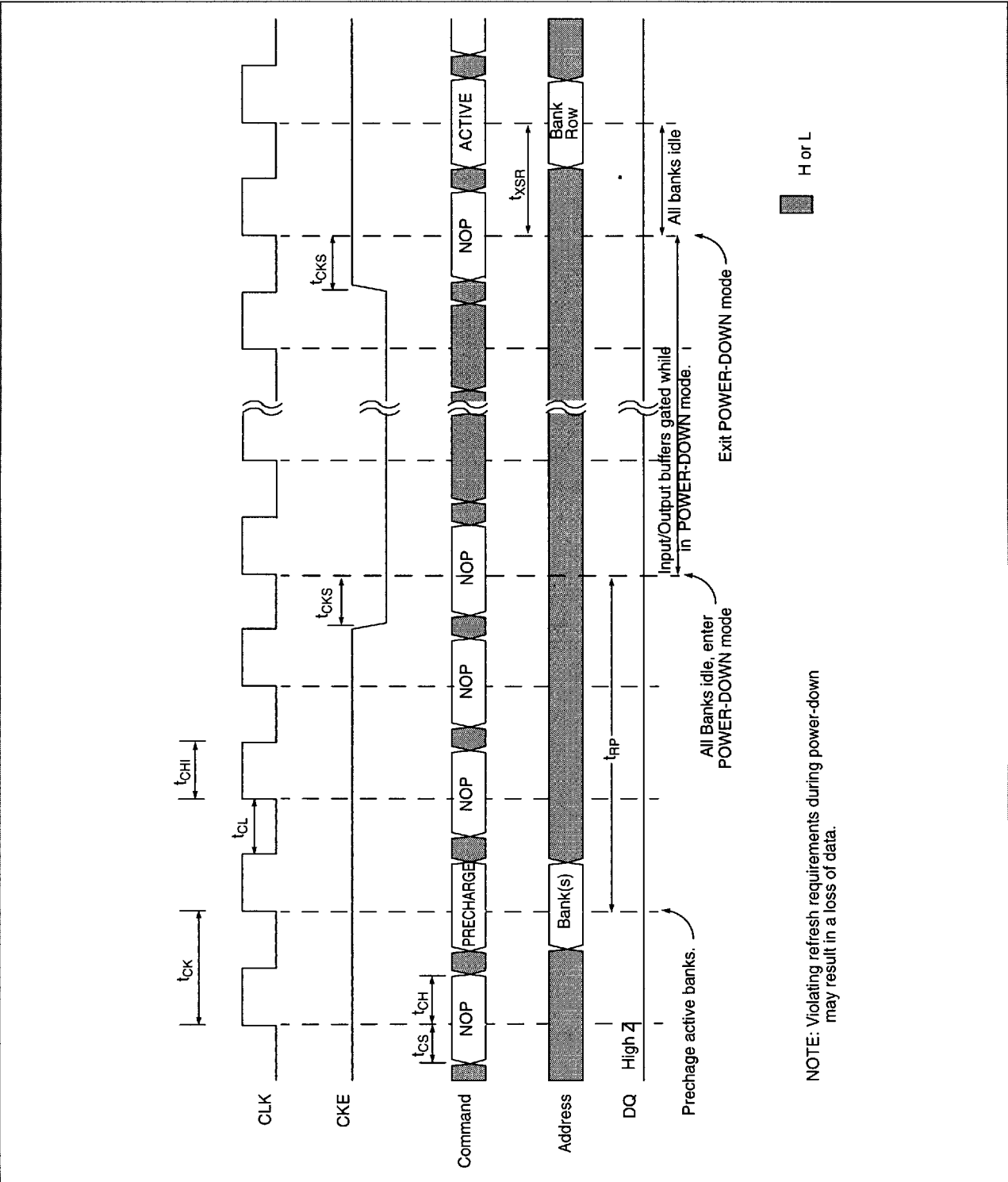
Exiting Self Refresh at clock edge n will put the device in the "all banks idle" state once t_{XSR} is met. NOP commands should be issued on any clock edges occurring during the t_{XSR} period.

Logic Table for Self Refresh

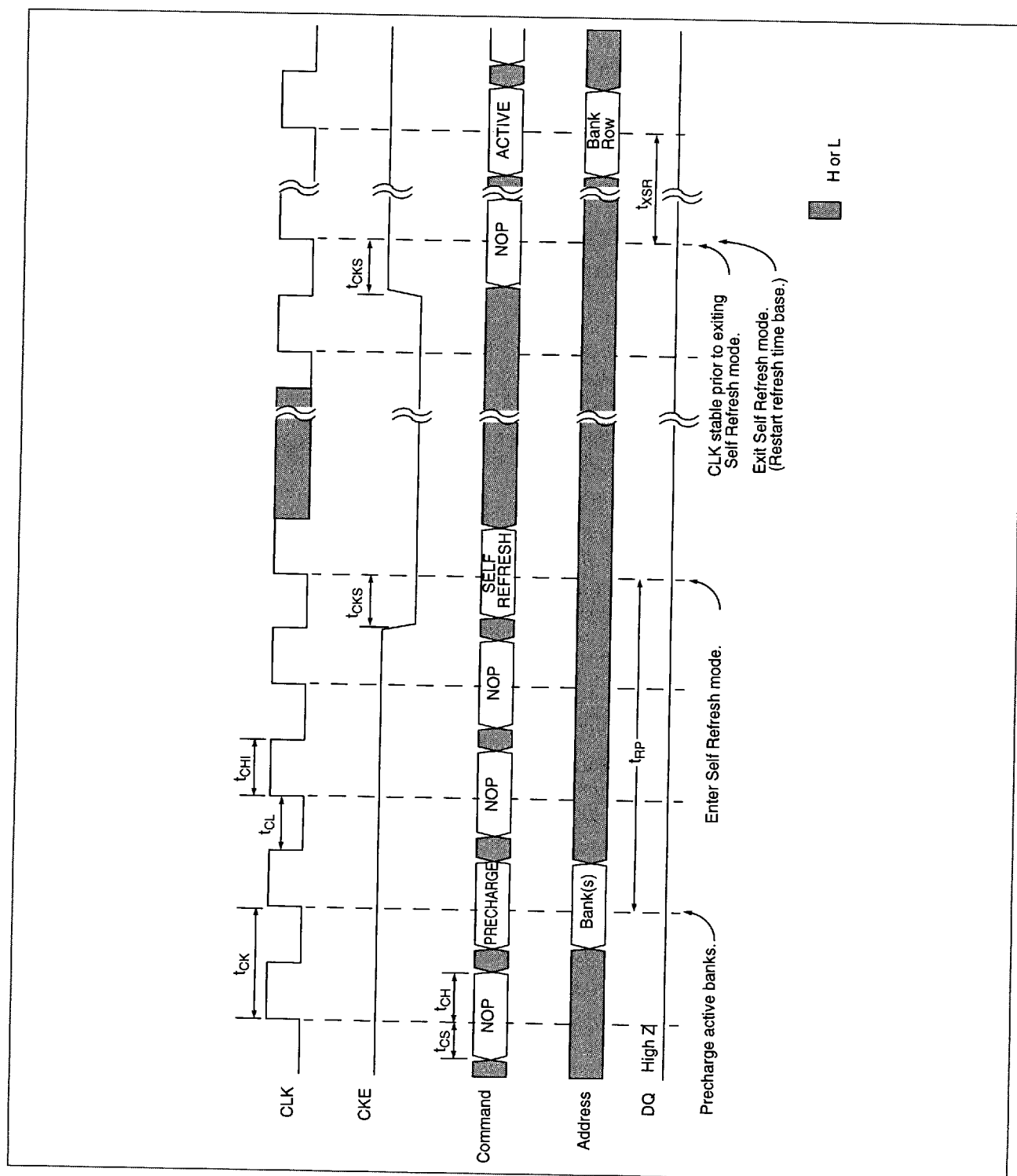
| Mnemonic | CKE | | \overline{CS} | \overline{RAS} | \overline{CAS} | \overline{WE} | DSF | DQM | A_9 | A_8 | A_7-A_0 |
|------------|-------|-----|-----------------|------------------|------------------|-----------------|-----|-----|-------|-------|-----------|
| | $n-1$ | n | | | | | | | | | |
| SREF (ENT) | H | L | L | L | L | H | L | X | X | X | X |
| SREF (EXT) | L | H | H | X | X | X | X | X | X | X | X |
| | L | H | L | H | H | H | X | X | X | X | X |

The following page shows the timing diagrams for the Power Down mode and the Self Refresh mode. Entry into these modes and exit from these modes are also illustrated.

Power Down Mode



Self Refresh Mode



Package Diagram

